

Ultra-Low Quiescent Current, Synchronous Step-Down PFM DC/DC Converter with Output voltage selectable function

☆ Green Operation compatible

■ GENERAL DESCRIPTION

The XC9276 Series is a 150mA step-down synchronous rectification DC/DC converter which has an output voltage switch-over function with an ultra-low power consumption circuit and a PFM control.

The efficiency performance at a light load current is dramatically improved by implementing ultra-low power consumption circuits which has 200nA consumption current, and PFM control method. Additionally two-preset output voltage switchover function is available with using V_{SET} pin.

This function can select an appropriate output voltage based on the MCU behavior mode and contribute a power consumption reduction for a total system. Due to these functions, XC9276 series are suitable for equipment which needs a high efficiency performance at a light load current, and a long-time battery life.

XC9276 series are compatible to 2.2μH inductor therefore it can reduce an output ripple voltage which is a negative side of PFM control method, and a PCB board area size.

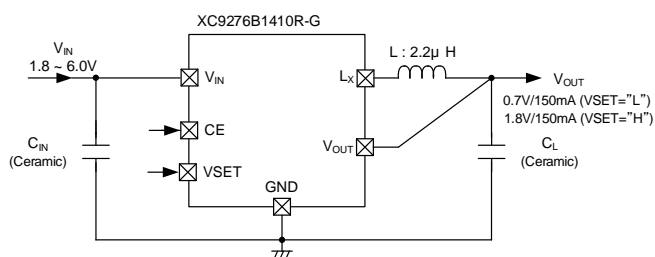
■ APPLICATIONS

- Smart meter
- Low Power RF
- Sensor Module
- Wearable Devices
- Energy Harvest devices
- Back-up power supply circuit
- Smart card
- Devices with 1 Lithium cell

■ FEATURES

| | | |
|-------------------------------|---|---|
| Input Voltage Range | : | 1.8V ~ 6.0V |
| Output Voltage Setting | : | 0.5V ~ 1.9V (0.05V increments) 2.0V ~ 3.6V (0.1V increments) |
| Output Voltage Accuracy | : | ±20mV ($V_{OUT1,2} \leq 1.0V$) ±2.0% ($V_{OUT1,2} > 1.0V$) |
| Output Current | : | 150mA |
| Supply Current | : | 200nA @ $V_{OUT}=1.8V$ (TYP.) |
| Control Method | : | PFM control |
| Function | : | Output Voltage selectable function C _L Discharge (D Type) UVLO function |
| Protection Functions | : | Short Protection |
| Input / Output Capacitor | : | Ceramic Capacitor Compatible |
| Operation Ambient Temperature | : | -40 ~ 85°C |
| Package | : | WLP-6-03 (1.72 x 1.07 x 0.33mm) SOT-26W (2.9 x 2.8 x 1.3mm) USP-8B06 (2.0 x 2.0 x 0.33mm) |
| Environmentally Friendly | : | EU RoHS compliant, Pb Free |

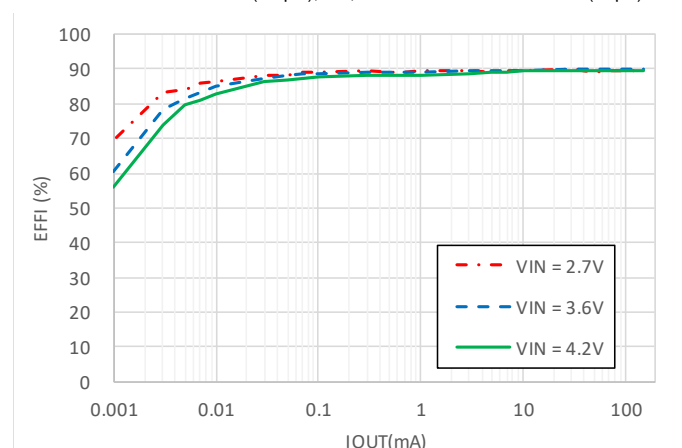
■ TYPICAL APPLICATION CIRCUIT



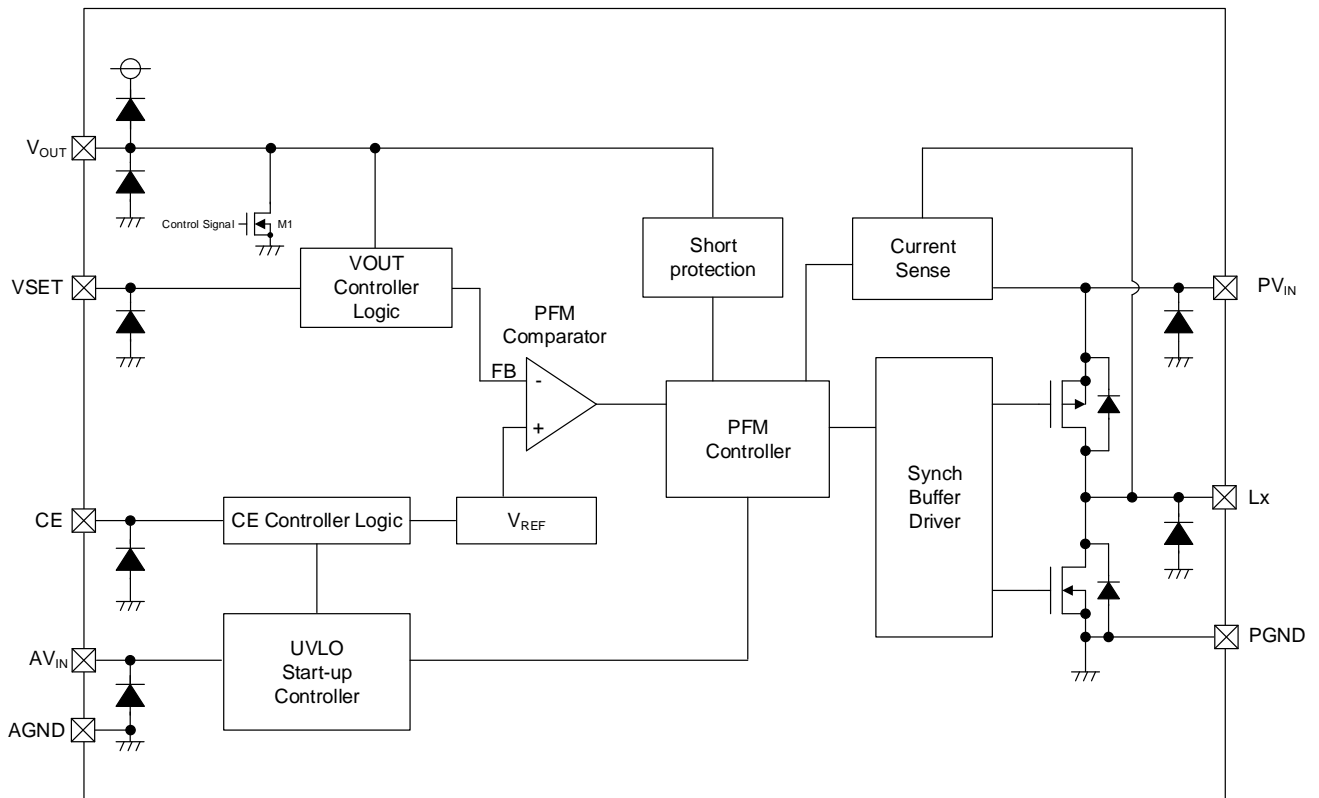
■ TYPICAL PERFORMANCE CHARACTERISTICS

$$V_{OUT} = 1.8V$$

$$L = \text{GLUHK2R201A}(2.2\mu\text{H}), C_{IN}, C_L = \text{GRM188R61A106ME69}(10\mu\text{F})$$



■ BLOCK DIAGRAM



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

XC9276B does not have C_L Discharge function.

For WLP-6-03 and SOT-26W, AVIN and PVIN are connected internally and the pin name is VIN.

Additionally AGND and PGND are also connected internally and the pin name is GND.

■ PRODUCT CLASSIFICATION

1) Ordering information

XC9276①②③④⑤⑥⑦

| DESIGNATOR | ITEM | SYMBOL | DESCRIPTION |
|------------|--------------------------|--------------------|--|
| ① | Product Type | B | Without C _L Discharge |
| | | D | With C _L Discharge |
| ②③④ (*2) | Output Voltage | Refer to the table | Output Voltage combination V _{OUT1} : 0.50V ~ 3.60V V _{OUT2} : 0.50V ~ 3.60V (V _{OUT1,2} ≤ 1.9V : 0.05V increments, V _{OUT1,2} > 1.9V : 0.1V increments) |
| ⑤⑥⑦ (*1) | Packages (Order Unit) | 0R-G | WLP-6-03 (5,000pcs/Reel) |
| | | MR-G | SOT-26W (3,000pcs/Reel) |
| | | ER-G | USP-8B06 (5,000pcs/Reel) |

(*1) The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

(*2) V_{OUT1} < V_{OUT2} is our standard specification.

With regard to other voltage options, please contact our sales representative.

● Symbols ②, ③, ④ : Output voltage combination example

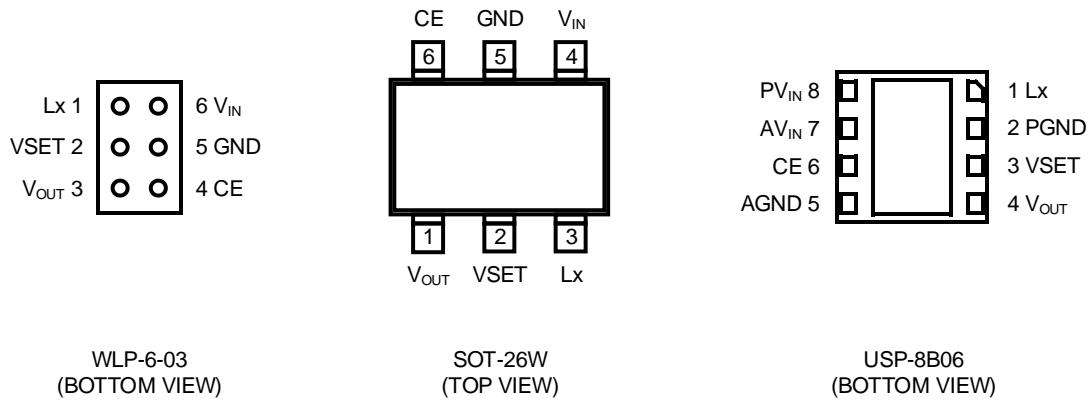
| ②③④ | | V _{OUT1} (V) | | | | | | | | | | | | | | | | | |
|-----------------------|------|-----------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| | | 0.50 | 0.60 | 0.65 | 0.70 | 0.80 | 0.90 | 1.00 | 1.10 | 1.20 | 1.30 | 1.50 | 1.80 | 1.85 | 2.00 | 2.20 | 2.50 | 3.00 | 3.30 |
| V _{OUT2} (V) | 0.50 | - | - | R04 | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - |
| | 0.60 | N02 | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - |
| | 0.65 | N03 | 001 | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - |
| | 0.70 | N04 | 002 | 061 | - | - | - | - | - | - | - | - | - | - | - | - | - | - | - |
| | 0.80 | N06 | 004 | 063 | 121 | - | - | - | - | - | - | - | - | - | - | - | - | - | - |
| | 0.90 | N08 | 006 | 065 | 123 | 236 | - | - | - | - | - | - | - | - | - | - | - | - | - |
| | 1.00 | N10 | 008 | 067 | 125 | 238 | 347 | - | - | - | - | - | - | - | - | - | - | - | - |
| | 1.10 | N12 | 010 | 069 | 127 | 240 | 349 | 454 | - | - | - | - | - | - | - | - | - | - | - |
| | 1.20 | N14 | 012 | 071 | 129 | 242 | 351 | 456 | 557 | - | - | - | - | - | - | - | - | - | - |
| | 1.30 | N16 | 014 | 073 | 131 | 244 | 353 | 458 | 559 | 656 | - | - | - | - | - | - | - | - | - |
| | 1.50 | N20 | 018 | 077 | 135 | 248 | 357 | 462 | 563 | 660 | 753 | - | - | - | - | - | - | - | - |
| | 1.80 | N26 | 024 | 083 | 141 | 254 | 363 | 468 | 569 | 666 | 759 | 933 | - | - | - | - | - | - | - |
| | 1.85 | N27 | 025 | 084 | 142 | 255 | 364 | 469 | 570 | 667 | 760 | 934 | B67 | - | - | - | - | - | - |
| | 2.00 | N30 | 028 | 087 | 145 | 258 | 367 | 472 | 573 | 670 | 763 | 937 | B70 | C06 | - | - | - | - | - |
| | 2.20 | N34 | 032 | 091 | 149 | 262 | 371 | 476 | 577 | 674 | 767 | 941 | B74 | C10 | D10 | - | - | - | - |
| | 2.50 | N40 | 038 | 097 | 155 | 268 | 377 | 482 | 583 | 680 | 773 | 947 | B80 | C16 | D16 | E35 | - | - | - |
| 3.00 | N50 | 048 | 107 | 165 | 278 | 387 | 492 | 593 | 690 | 783 | 957 | B90 | C26 | D26 | E45 | F93 | - | - | |
| 3.30 | N56 | 054 | 113 | 171 | 284 | 393 | 498 | 599 | 696 | 789 | 963 | B96 | C32 | D32 | E51 | F99 | K66 | - | |
| 3.60 | N62 | 060 | 119 | 177 | 290 | 399 | 504 | 605 | 702 | 795 | 969 | C03 | C38 | D38 | E57 | H06 | K72 | M24 | |

With regard to other voltage, please contact our sales representative.

2) Selection Guide

| FUNCTION | B TYPE | | D TYPE | |
|--------------------------|---|----------------------------|---|----------------------------|
| | V _{OUT1} or V _{OUT2} < 1.2V | V _{OUT1,2} ≥ 1.2V | V _{OUT1} or V _{OUT2} < 1.2V | V _{OUT1,2} ≥ 1.2V |
| Output Voltage | Output voltage selectable by VSET pin | | | |
| Short Protection | - | Yes | - | Yes |
| C _L Discharge | - | | Yes | |
| Chip Enable | Yes | | | |
| UVLO | Yes | | | |

PIN CONFIGURATION



* The dissipation pad should be solder-plated in recommended mount pattern and metal masking to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the PGND (No.2) pin and the AGND (No. 5) pin.

PIN ASSIGNMENT

| PIN NUMBER | | | PIN NAME | FUNCTION |
|------------|---------|----------|------------------|------------------------|
| WLP-6-03 | SOT-26W | USP-8B06 | | |
| 1 | 3 | 1 | Lx | Switching |
| 2 | 2 | 3 | VSET | Output Voltage control |
| 3 | 1 | 4 | V _{OUT} | Output Voltage |
| 4 | 6 | 6 | CE | Chip Enable |
| 5 | 5 | - | GND | Ground |
| 6 | 4 | - | V _{IN} | Input Voltage |
| - | - | 2 | PGND | Power Ground |
| - | - | 5 | AGND | Analog Ground |
| - | - | 7 | AV _{IN} | Analog Input |
| - | - | 8 | PV _{IN} | Power Input |

FUNCTION

| PIN NAME | SIGNAL | STATUS |
|----------|--------|----------|
| CE | H | Active |
| | L | Stand-by |

* Please do not leave the CE pin open.

| PIN NAME | SIGNAL | STATUS |
|----------|--------|-------------------|
| VSET | H | V _{OUT2} |
| | L | V _{OUT1} |

* Please do not leave the VSET pin open.

■ ABSOLUTE MAXIMUM RATINGS

| PARAMETER | | SYMBOL | RATINGS | UNITS |
|---|----------|------------------|--|-------|
| V _{IN} Pin Voltage | | V _{IN} | -0.3 ~ 7.0 | V |
| Lx Pin Voltage | | V _{LX} | -0.3 ~ V _{IN} + 0.3 or 7.0 ^(*) | V |
| V _{OUT} Pin Voltage | | V _{OUT} | -0.3 ~ V _{IN} + 0.3 or 7.0 ^(*) | V |
| CE Pin Voltage | | V _{CE} | -0.3 ~ 7.0 | V |
| VSET Pin Voltage | | VSET | -0.3 ~ 7.0 | V |
| Power Dissipation (T _a =25°C) | WLP-6-03 | P _d | 840 (JESD51-7 board) ^(**) | mW |
| | SOT-26W | | 820 (JESD51-7 board) ^(**) | |
| | USP-8B06 | | 1240 (JESD51-7 board) ^(**) | |
| Operating Ambient Temperature | | T _{opr} | -40 ~ 85 | °C |
| Storage Temperature | | T _{stg} | -55 ~ 125 | °C |

* All voltages are described based on the GND pin. For USP-8B06, AV_{IN} and PV_{IN} must be shorted and handled as V_{IN}.

^(*) The maximum value should be either V_{IN}+0.3V or 7.0V in the lowest.

^(**) The power dissipation figure shown is PCB mounted and is for reference only.

The mounting condition is please refer to PACKAGING INFORMATION.

ELECTRICAL CHARACTERISTICS

Ta=25°C

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS | CIRCUIT | |
|--|---|---|----------------------------|-------|-------|--------|---------|---|
| Output Voltage1 ⁽¹⁾ | V _{OUT1} | When connected to external components, VSET = 0.0V, I _{OUT} = 30mA | - | <T-1> | - | V | ① | |
| Output Voltage1-2 | V _{OUT1-2} | VSET = 0.0V, Voltage which Lx pin changes "H" to "L" level while V _{OUT} is increase. ⁽⁶⁾ | <E-1> | <E-2> | <E-3> | V | ② | |
| Output Voltage2 ⁽¹⁾ | V _{OUT2} | When connected to external components, VSET = V _{IN} , I _{OUT} = 30mA | - | <T-1> | - | V | ① | |
| Output Voltage2-2 | V _{OUT2-2} | VSET = V _{IN} , Voltage which Lx pin changes "H" to "L" level while V _{OUT} is increase. ⁽⁶⁾ | <E-1> | <E-2> | <E-3> | V | ② | |
| Operating Voltage Range | V _{IN} | - | 1.8 | - | 6.0 | V | ① | |
| Maximum Output Current | I _{OUTMAX} | When connected to external components ⁽²⁾ | 150 | - | - | mA | ① | |
| UVLO Release Voltage | V _{UVLOR} | V _{OUT} = 0.0V, V _{CE} = VSET = 1.8V Voltage which Lx pin holding "H" level ⁽⁶⁾ | Ta=25°C | - | 1.50 | 1.78 | V | ② |
| | | | Ta=-40~85°C ⁽³⁾ | - | - | - | - | - |
| UVLO Detect Voltage | V _{UVLOD} | V _{OUT} = 0.0V, V _{CE} = VSET = 1.8V Voltage which Lx pin holding "L" level ⁽⁶⁾ | Ta=25°C | 1.00 | 1.40 | - | V | ② |
| | | | Ta=-40~85°C ⁽³⁾ | 1.00 | 1.40 | - | V | ② |
| Quiescent Current | I _q | V _{IN} = V _{CE} = <C-1>, VSET = 0.0V, V _{OUT} = V _{OUT1} × 1.05 | - | <E-4> | <E-5> | nA | ③ | |
| Stand-by Current | I _{STB} | V _{IN} = 6.0V, V _{CE} = V _{OUT} = 0.0V | - | 0.0 | 0.1 | μA | ③ | |
| PFM Switching Current | I _{PFM} | When connected to external components, V _{IN} = V _{OUT(T)} + 2.0V, I _{OUT} = 10mA | - | 400 | 600 | mA | ① | |
| Efficiency | EFFI | I _{OUT} = 30mA | - | <E-6> | - | % | ① | |
| Lx SW "H" ON Resistance ⁽⁴⁾ | R _{LXH} | V _{OUT} = 0.0V, V _{IN} = V _{CE} = VSET = 5.0V, I _{LX} = 50mA | - | 0.35 | 0.45 | Ω | ④ | |
| Lx SW "L" ON Resistance ⁽³⁾ | R _{LXL} | V _{IN} = 5.0V | - | 0.32 | 0.42 | Ω | - | |
| Lx SW "H" Leakage Current | I _{LeakH} | V _{IN} = 6.0V, V _{OUT} = V _{CE} = VSET = 0.0V, V _{LX} = 6.0V | - | 0.0 | 0.1 | μA | ④ | |
| Lx SW "L" Leakage Current | I _{LeakL} | V _{IN} = 6.0V, V _{OUT} = V _{CE} = VSET = 0.0V, V _{LX} = 0.0V | - | 0.0 | 0.1 | μA | ④ | |
| Output Voltage Temperature Characteristics | $\frac{\Delta V_{OUT}}{V_{OUT}}$ (V _{OUT} = V _{OUT1}) $\frac{\Delta T_{opr}}{T_{opr}}$ | I _{OUT} = 30mA -40°C ≤ T _{opr} ≤ 85°C | - | ±100 | - | ppm/°C | ① | |

Unless otherwise stated, V_{IN}=5V, V_{CE}=5V, V_{OUT(T)}=Nominal Value

(*1) V_{OUT1} and V_{OUT2} are the average values of the output voltage considering the ripple voltage and they are set so that they can be a setting output voltage with this evaluation condition.

(*2) The maximum output current performance varies based on a voltage difference between an input voltage and an output voltage, and external components and so on. Regarding detail of this variation, please refer to OPERATIONAL EXPLANATION and NOTE ON USE section.

(*3) Design value

(*4) Design value for WLP-6-03

(*5) SHORT PROTECTION with LATCH is not available if V_{OUT1} is 1.2V or less.

(*6) "H" = V_{IN} ~ V_{IN} -1.2V, "L" = 0.1V ~ -0.1V

■ ELECTRICAL CHARACTERISTICS

Ta=25°C

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS | CIRCUIT | |
|---|--------------------|--|-----------------------------|------|------|-------|---------|---|
| CE "H" Voltage | V _{CEH} | VSET = V _{IN} , V _{OUT} = 0.0V, Voltage which Lx pin holding "H" level ^(*6) | Ta=25°C | 1.2 | - | 6.0 | V | ② |
| | | | Ta=-40~85°C ^(*3) | | | | | |
| CE "L" Voltage | V _{CEL} | VSET = V _{IN} , V _{OUT} = 0.0V, Voltage which Lx pin holding "L" level ^(*6) | Ta=25°C | GND | - | 0.3 | V | ② |
| | | | Ta=-40~85°C ^(*3) | | | | | |
| CE "H" Current | I _{CEH} | V _{IN} = 6.0V, V _{OUT} = 0.0V, V _{CE} = 6.0V, VSET = 6.0V | -0.1 | 0.0 | 0.1 | μA | ④ | |
| CE "L" Current | I _{CEL} | V _{IN} = 6.0V, V _{OUT} = 0.0V, V _{CE} = 0.0V, VSET = 6.0V | -0.1 | 0.0 | 0.1 | μA | ④ | |
| VSET "H" Voltage | VSET _H | V _{OUT} = (V _{OUT1} + V _{OUT2}) / 2, V _{OUT1} < V _{OUT2} →Voltage which Lx pin holding "H" level ^(*6) V _{OUT1} > V _{OUT2} →Voltage which Lx pin holding "L" level ^(*6) | Ta=25°C | 1.2 | - | 6.0 | V | ② |
| | | | Ta=-40~85°C ^(*3) | | | | | |
| VSET "L" Voltage | VSET _L | V _{OUT} = (V _{OUT1} + V _{OUT2}) / 2, V _{OUT1} < V _{OUT2} →Voltage which Lx pin holding "L" level ^(*6) V _{OUT1} > V _{OUT2} →Voltage which Lx pin holding "H" level ^(*6) | Ta=25°C | GND | - | 0.3 | V | ② |
| | | | Ta=-40~85°C ^(*3) | | | | | |
| VSET "H" Current | I _{VSETH} | V _{IN} = 6.0V, V _{OUT} = 0.0V, V _{CE} = 6.0V, VSET = 6.0V | -0.1 | 0.0 | 0.1 | μA | ④ | |
| VSET "L" Current | I _{VSETL} | V _{IN} = 6.0V, V _{OUT} = 0.0V, V _{CE} = 6.0V, VSET = 0.0V | -0.1 | 0.0 | 0.1 | μA | ④ | |
| Short Protection Threshold Voltage ^(*5) | V _{SHORT} | VSET = 5.0V, Voltage which Lx pin holding "L" level ^(*6) | Ta=25°C | 0.10 | 0.54 | 0.80 | V | ② |
| | | | Ta=-40~85°C ^(*3) | | | | | |
| C _L Discharge (Type D) | R _{DCHG} | V _{IN} = 5.0V, V _{CE} = 0.0V, V _{OUT} = 0.1V, VSET = 5.0V | 29 | 45 | 60 | Ω | ② | |

Unless otherwise stated, V_{IN}=5V, V_{CE}=5V, V_{OUT(T)}=Nominal Value

(*1) V_{OUT1} and V_{OUT2} are the average values of the output voltage considering the ripple voltage and they are set so that they can be a setting output voltage with this evaluation condition.

(*2) The maximum output current performance varies based on a voltage difference between an input voltage and an output voltage, and external components and so on. Regarding detail of this variation, please refer to OPERATIONAL EXPLANATION and NOTE ON USE section.

(*3) Design value

(*4) Design value for WLP-5-06

(*5) SHORT PROTECTION with LATCH is not available if V_{OUT1} is 1.2V or less.

(*6) "H" = V_{IN} ~ V_{IN} - 1.2V, "L" = 0.1V ~ -0.1V

ELECTRICAL CHARACTERISTICS

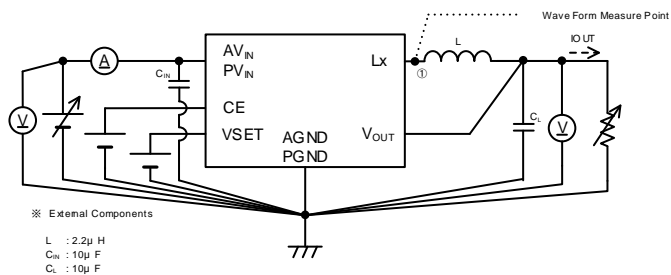
SPEC Table

| Nominal Output Voltage $V_{OUT(T)}$ | $V_{OUT1}, V_{OUT1-2}, V_{OUT2}, V_{OUT2-2}, (V)$ | | | | $V_{IN} (V)$ | $I_q (nA)$ | | EFFI (%) |
|---|---|-------|-------|-------|--------------|------------|-------|----------|
| | <T-1> | <E-1> | <E-2> | <E-3> | <C-1> | <E-4> | <E-5> | <E-6> |
| | TYP. | MIN. | TYP. | MAX. | V_{IN} | TYP. | MAX. | TYP. |
| 0.50 | 0.500 | 0.460 | 0.480 | 0.500 | 1.80 | 200 | 600 | 75.9 |
| 0.60 | 0.600 | 0.560 | 0.580 | 0.600 | 1.80 | 200 | 600 | 77.1 |
| 0.70 | 0.700 | 0.660 | 0.680 | 0.700 | 1.80 | 200 | 600 | 78.3 |
| 0.80 | 0.800 | 0.760 | 0.780 | 0.800 | 1.80 | 200 | 600 | 79.4 |
| 0.90 | 0.900 | 0.860 | 0.880 | 0.900 | 1.80 | 200 | 600 | 80.4 |
| 1.00 | 1.000 | 0.960 | 0.980 | 1.000 | 1.80 | 200 | 600 | 81.5 |
| 1.10 | 1.100 | 1.058 | 1.080 | 1.102 | 1.80 | 200 | 600 | 82.5 |
| 1.20 | 1.200 | 1.156 | 1.180 | 1.204 | 1.80 | 200 | 600 | 83.4 |
| 1.30 | 1.300 | 1.254 | 1.280 | 1.306 | 1.80 | 200 | 600 | 84.3 |
| 1.40 | 1.400 | 1.352 | 1.380 | 1.408 | 1.90 | 200 | 600 | 85.2 |
| 1.50 | 1.500 | 1.450 | 1.480 | 1.510 | 2.00 | 200 | 600 | 86.0 |
| 1.60 | 1.600 | 1.548 | 1.580 | 1.612 | 2.10 | 200 | 600 | 86.8 |
| 1.70 | 1.700 | 1.646 | 1.680 | 1.714 | 2.20 | 200 | 600 | 87.5 |
| 1.80 | 1.800 | 1.744 | 1.780 | 1.816 | 2.30 | 200 | 600 | 88.2 |
| 1.90 | 1.900 | 1.842 | 1.880 | 1.918 | 2.40 | 200 | 600 | 88.9 |
| 2.00 | 2.000 | 1.940 | 1.980 | 2.020 | 2.50 | 210 | 630 | 89.5 |
| 2.10 | 2.100 | 2.038 | 2.080 | 2.122 | 2.60 | 210 | 630 | 90.1 |
| 2.20 | 2.200 | 2.136 | 2.180 | 2.224 | 2.70 | 210 | 630 | 90.6 |
| 2.30 | 2.300 | 2.234 | 2.280 | 2.326 | 2.80 | 210 | 630 | 91.1 |
| 2.40 | 2.400 | 2.332 | 2.380 | 2.428 | 2.90 | 210 | 630 | 91.6 |
| 2.50 | 2.500 | 2.430 | 2.480 | 2.530 | 3.00 | 220 | 660 | 92.0 |
| 2.60 | 2.600 | 2.528 | 2.580 | 2.632 | 3.10 | 220 | 660 | 92.3 |
| 2.70 | 2.700 | 2.626 | 2.680 | 2.734 | 3.20 | 220 | 660 | 92.6 |
| 2.80 | 2.800 | 2.724 | 2.780 | 2.836 | 3.30 | 220 | 660 | 92.9 |
| 2.90 | 2.900 | 2.822 | 2.880 | 2.938 | 3.40 | 230 | 690 | 93.2 |
| 3.00 | 3.000 | 2.920 | 2.980 | 3.040 | 3.50 | 230 | 690 | 93.4 |
| 3.10 | 3.100 | 3.018 | 3.080 | 3.142 | 3.60 | 230 | 690 | 93.5 |
| 3.20 | 3.200 | 3.116 | 3.180 | 3.244 | 3.70 | 240 | 720 | 93.6 |
| 3.30 | 3.300 | 3.214 | 3.280 | 3.346 | 3.80 | 240 | 720 | 93.7 |
| 3.40 | 3.400 | 3.312 | 3.380 | 3.448 | 3.90 | 240 | 720 | 93.7 |
| 3.50 | 3.500 | 3.410 | 3.480 | 3.550 | 4.00 | 250 | 750 | 93.7 |
| 3.60 | 3.600 | 3.508 | 3.580 | 3.652 | 4.10 | 250 | 750 | 93.7 |

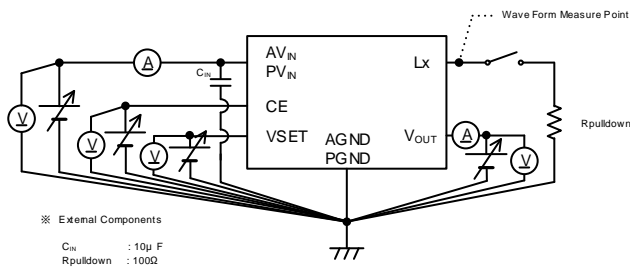
With regard to other voltage, please contact our sales representative.

TEST CIRCUITS

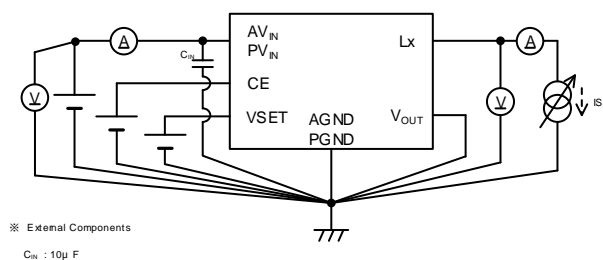
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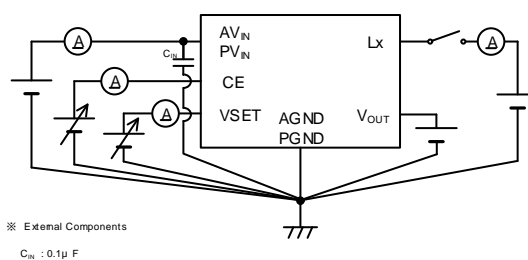
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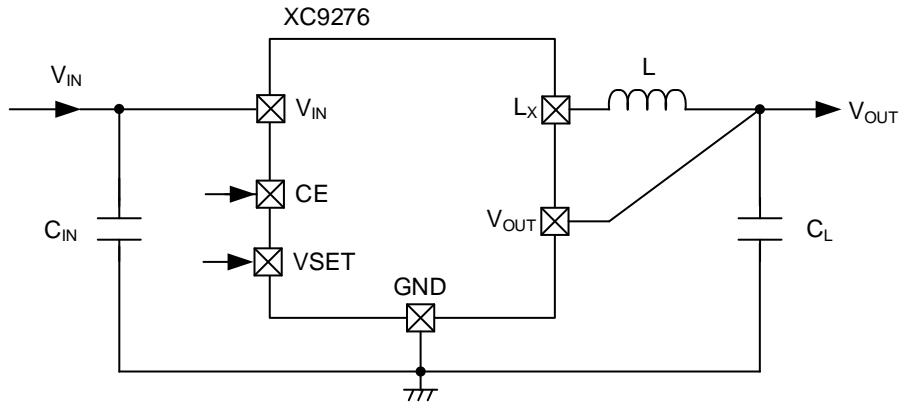
< Test Circuit No.③ >



< Test Circuit No.④ >



TYPICAL APPLICATION CIRCUIT



【Typical Examples】

| | Manufacture | Product Number | Value | Size |
|----------|-------------|---------------------|-----------------|-------------------|
| L | Murata | DFE18SBN2R2MELL | 2.2 μ H | 1.6 x 0.8 x 0.8mm |
| | | DFE252010F-2R2M | | 2.5 x 2.0 x 1.0mm |
| | TDK | MLP2520V2R2MT0S1 | | 2.5 x 2.0 x 1.0mm |
| | Taiyo Yuden | MEKK2016H2R2M | | 2.0 x 1.6 x 0.8mm |
| | Sunlord | MWTC201608S2R2MT | | 2.0 x 1.6 x 0.8mm |
| | Alps Alpine | GLUHK2R201A | | 2.0 x 1.6 x 1.0mm |
| C_{IN} | Murata | GRM188R61A106ME69 | 10 μ F/10V | 1.6 x 0.8 x 1.0mm |
| | Taiyo Yuden | LMK107BBJ106MALT | | 1.6 x 0.8 x 1.0mm |
| C_L | Murata | GRM188R61A106ME69 | 10 μ F/10V | 1.6 x 0.8 x 1.0mm |
| | | GRM188R60J226MEA0 | 22 μ F/6.3V | 1.6 x 0.8 x 1.0mm |
| | | GRM188R61A226ME15 | 22 μ F/10V | 1.6 x 0.8 x 1.0mm |
| | | GRM188R60J476ME15 | 47 μ F/6.3V | 1.6 x 0.8 x 1.0mm |
| | Taiyo Yuden | LMK107BBJ106MALT | 10 μ F/10V | 1.6 x 0.8 x 1.0mm |
| | | JMK107BBJ226MA | 22 μ F/6.3V | 1.6 x 0.8 x 1.0mm |
| | TDK | C1608X5R0J226M080AC | 22 μ F/6.3V | 1.6 x 0.8 x 1.0mm |

* Please select the components taking into consideration the rated voltage, rated current, and ceramic capacitor DC bias characteristics, etc.

* An inductance value of 2.2 μ H \pm 20% or \pm 30% is recommended.

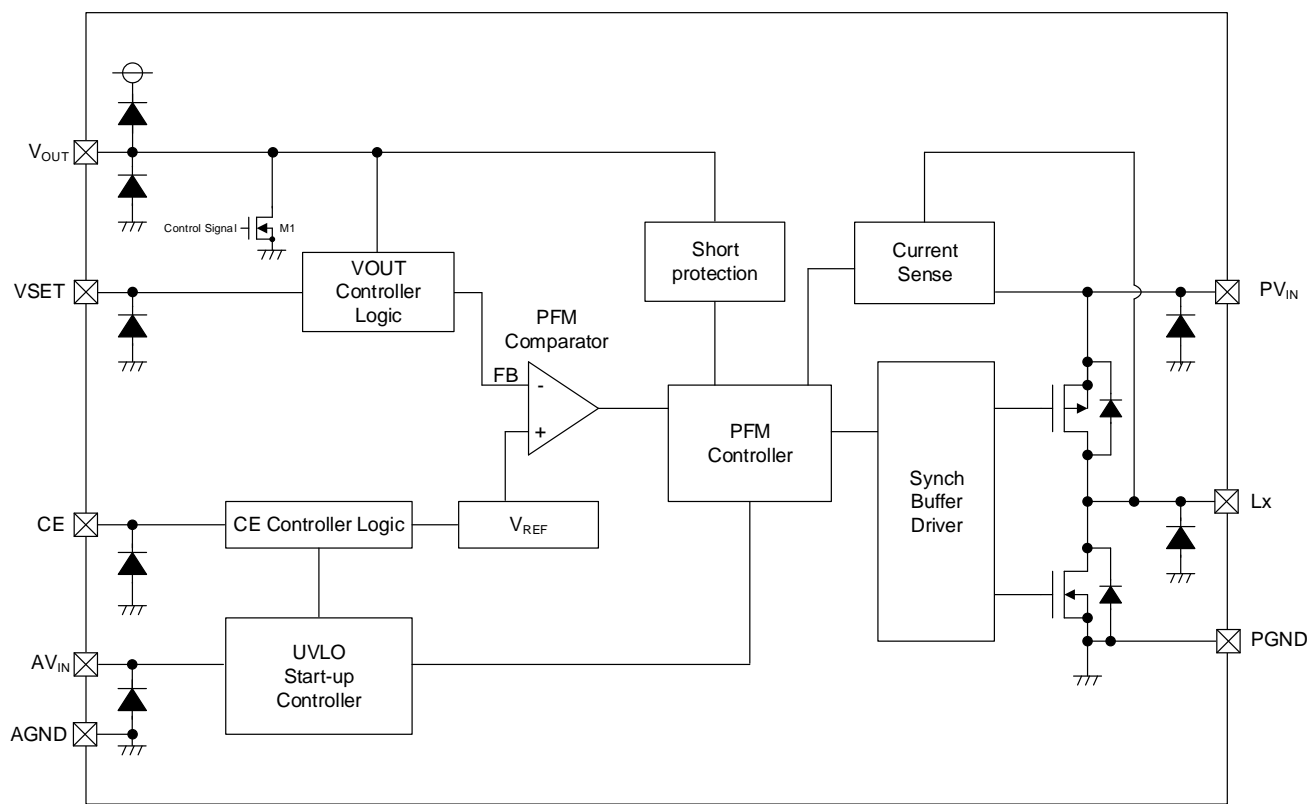
An inductor which is out of our recommendation value or has poor DC superimposition characteristics can attribute to a reduction of an output current performance and an efficiency performance.

* Please increase a capacitance value for C_L in order to reduce output ripple voltages.

C_L such as tantalum capacitors which have a larger ESR value can increase output ripple voltages.

■ OPERATIONAL EXPLANATION

The XC9276 series consists of a reference voltage supply, PFM comparator, Pch driver FET, Nch driver FET, current sensing circuit, PFM control circuit, CE control circuit, and others.



BLOCK DIAGRAM

The efficiency performance at a light load current is significantly improved compared to existing Torex products by implementing a current limit PFM as a control method and reducing a consumption current by IC itself.

OPERATIONAL EXPLANATION (Continued)

<Normal operation>

This IC controls the output voltage by adjusting the following ①~③ operation intervals in response to the output current.

The V_{OUT1} and V_{OUT2} output voltage average values during actual operation depend on V_{OUT1-2} , V_{OUT2-2} , and the ripple voltage during actual operation and are calculated as follows. For this reason, if the ripple voltage changes due to the influence of the input voltage, output voltage, or peripheral components, etc., the output voltage average value will change.

$$V_{OUT1} = V_{OUT1-2} + \text{Ripple Voltage} \times 1/2 \text{ (VSET= "L")}$$

$$V_{OUT2} = V_{OUT2-2} + \text{Ripple Voltage} \times 1/2 \text{ (VSET= "H")}$$

① The feedback voltage (FB voltage) is the voltage that results from dividing the output voltage with the VOUT Controller logic circuit. The PFM comparator compares this FB voltage to V_{REF} . When the FB voltage is lower than V_{REF} , the PFM comparator sends a signal to the PFM control circuit to turn on the Pch driver FET.

The On Time to Pch driver FET can be obtained by the following equation.

$$t_{ON} = L \times I_{PFM} / (V_{IN} - V_{OUT})$$

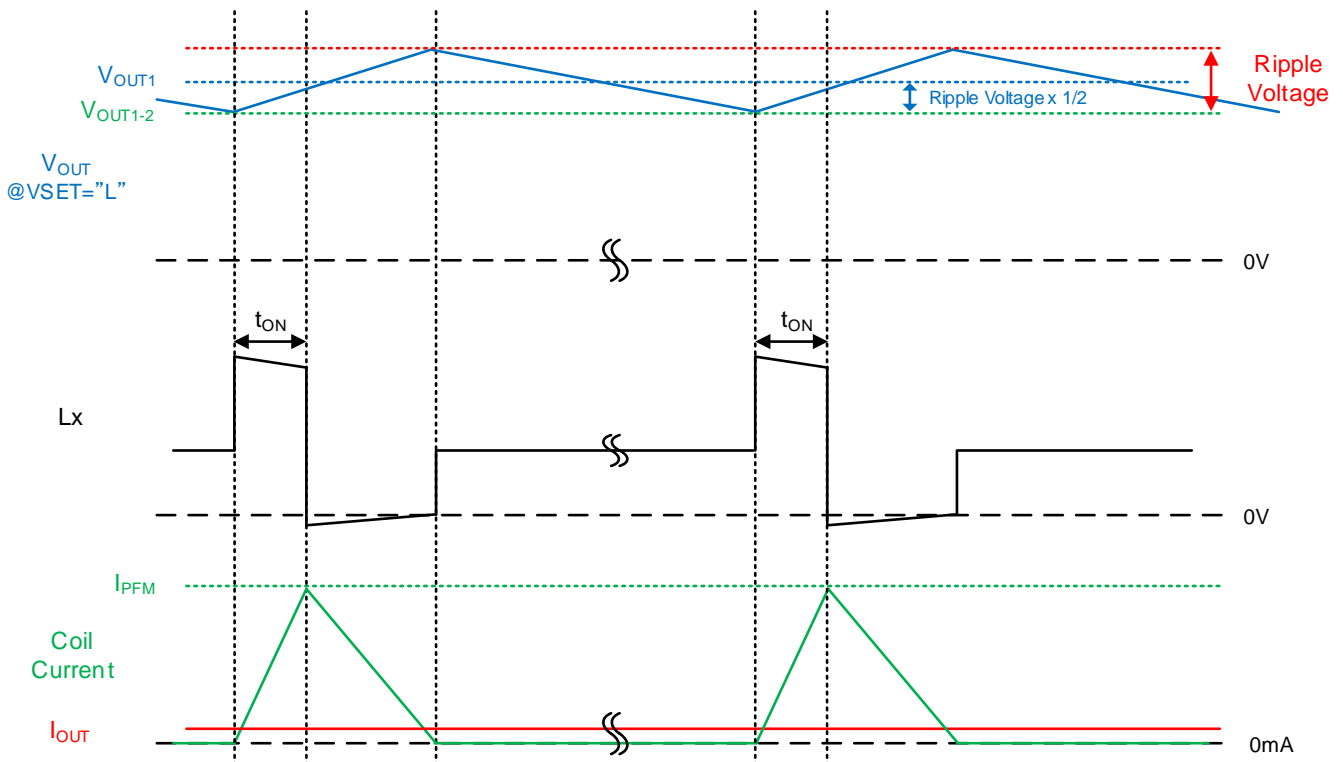
② When the Pch driver FET turns on, the coil current increases until the coil current reaches PFM Switching Current (I_{PFM}).

When the coil current reaches I_{PFM} , the Pch driver FET turns off and then the Nch driver FET turns on.

③ After the Nch driver FET turns on, the coil current will decrease and when the coil current goes down to approx. 0mA, the Nch driver FET will turn off.

The Pch driver FET and Nch driver FET remain off until the FB voltage becomes lower than the reference voltage V_{REF} .

The above ①~③ switching operations increase the FB voltage accompanying the output voltage increase, but if the PFM comparator determines the FB voltage is lower than the reference voltage V_{REF} before the coil current reaches 0mA, the Nch driver FET turns off and the status moves to ①.



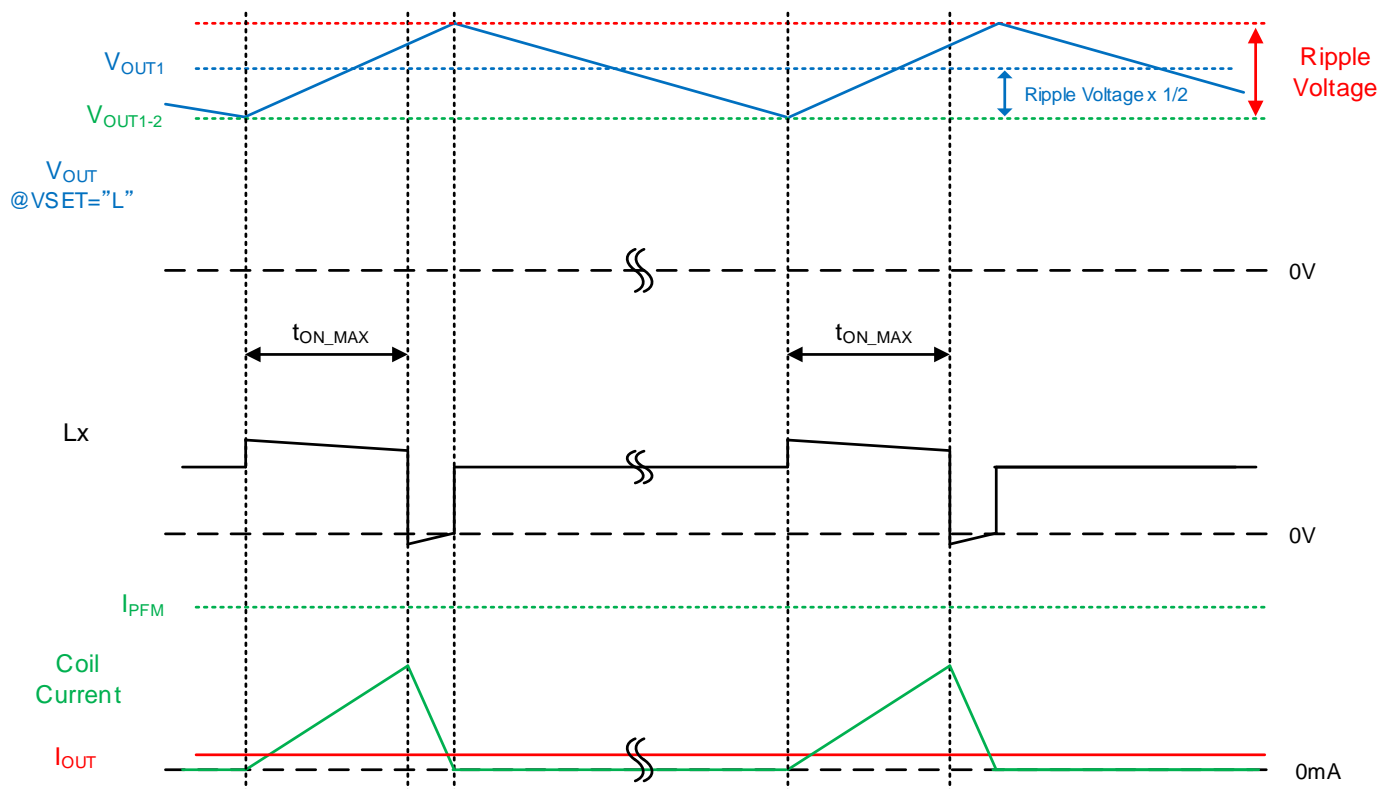
OPERATIONAL EXPLANATION (Continued)

< Maximum on-time function, 100% Duty operation >

When the input / output potential difference decreases, the on-time required for the coil current to reach I_{PFM} increases, and the output ripple voltage tends to increase. Therefore, under conditions where the input / output potential difference is small, excessive ripple voltage is suppressed by limiting the maximum on-time that the Pch driver FET can turn on after the FB voltage becomes higher than the reference voltage V_{REF} to $3.0\mu s$ (TYP.).

If the input / output potential difference is further reduced, the FB voltage is always lower than the reference voltage V_{REF} , so the 100% duty operation is performed and the Pch driver FET is always on.

At 100% duty, the current consumption of the IC increases compared to normal operation.



OPERATIONAL EXPLANATION (Continued)

<CE function>

When "H" voltage (V_{CEH}) is fed to the CE pin, normal operation starts after raising the output voltage with Start-up Mode.

When the "L" voltage (V_{CEL}) is fed to the CE pin, it enters the stand-by state and the current consumption is suppressed to $0.0\mu\text{A}$ (TYP.). Additionally, Pch MOS driver FET and Nch MOS driver FET are turned off.

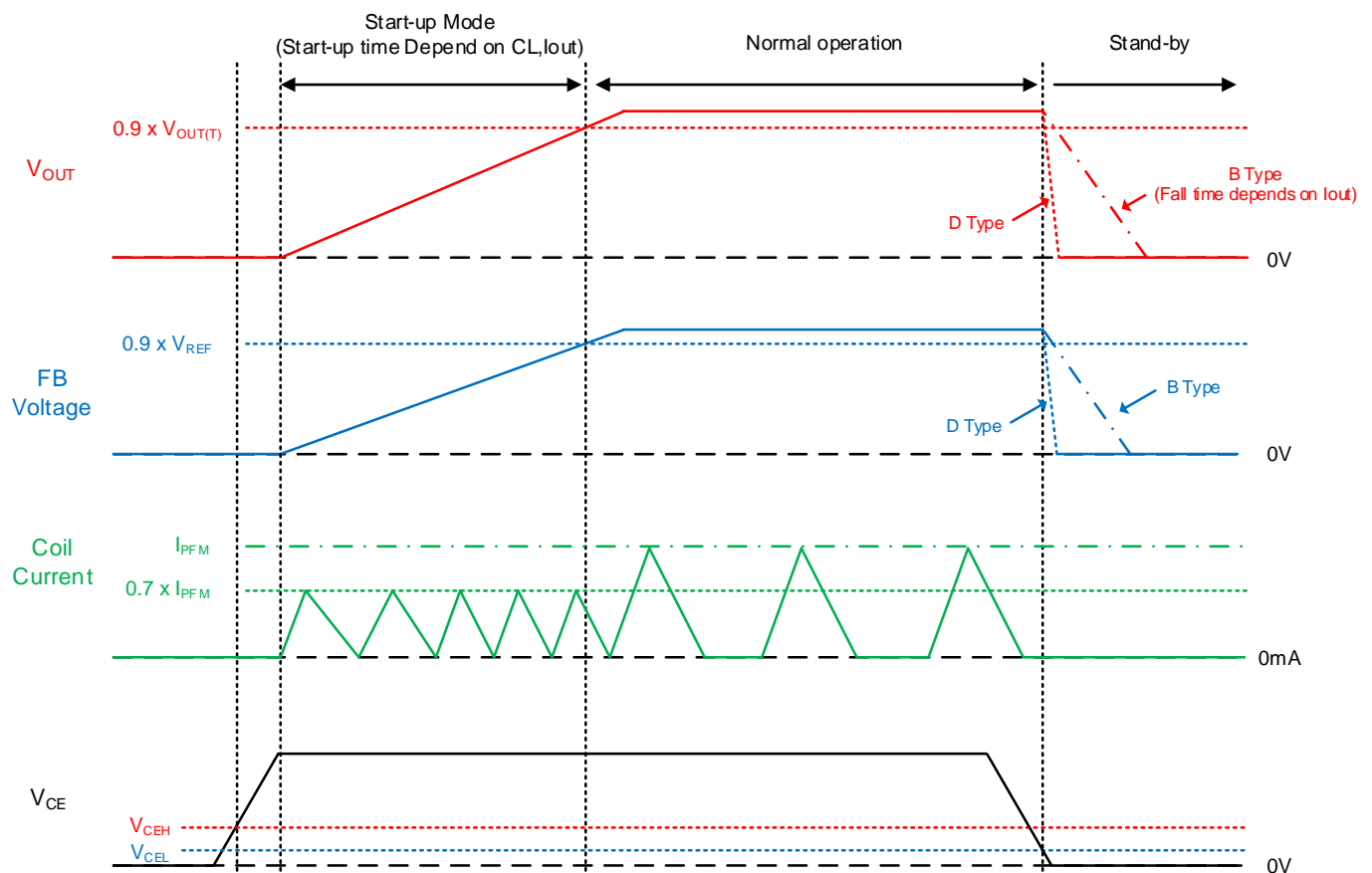
<Start-up Mode>

After "H" voltage (V_{CEH}) is fed to CE pin and UVLO function is released, by the time when FB voltage goes up to $0.9 \times V_{REF}$, the startup mode operates.

Unlike the normal operation, the start-up mode stops the operation of the short-circuit protection function and prevents the IC from being inadvertently stopped.

In order to suppress the inrush current, the peak current of the coil is limited to $0.7 \times I_{PFM}$, and the Nch driver FET does not turn on and the coil current flows through the parasitic diode of the Nch driver FET.

The rise time of the output voltage depends on the output capacitance and output current.



<UVLO function>

When the V_{IN} voltage becomes UVLO Detect Voltage (V_{UVLOD}) or less, the UVLO function operates to forcibly turn off the Pch MOS driver FET to prevent erroneous pulse output due to operation instability of the internal circuit.

During the UVLO function, the Pch driver FET and Nch driver FET turn off, and the Nch FET M1 between the V_{OUT} pin and GND pin turns on to discharge the output capacitance and make the output voltage be lower.

When the V_{IN} voltage becomes UVLO Release Voltage (V_{UVLOR}) or more, the UVLO function is canceled. After the UVLO function is canceled, the output voltage rises with the startup mode, and then the normal operation is performed.

Moreover, during the UVLO operation, the current consumption increases because the internal circuit is operating and the switching operation is stopped, not the stand-by state.

■ OPERATIONAL EXPLANATION (Continued)

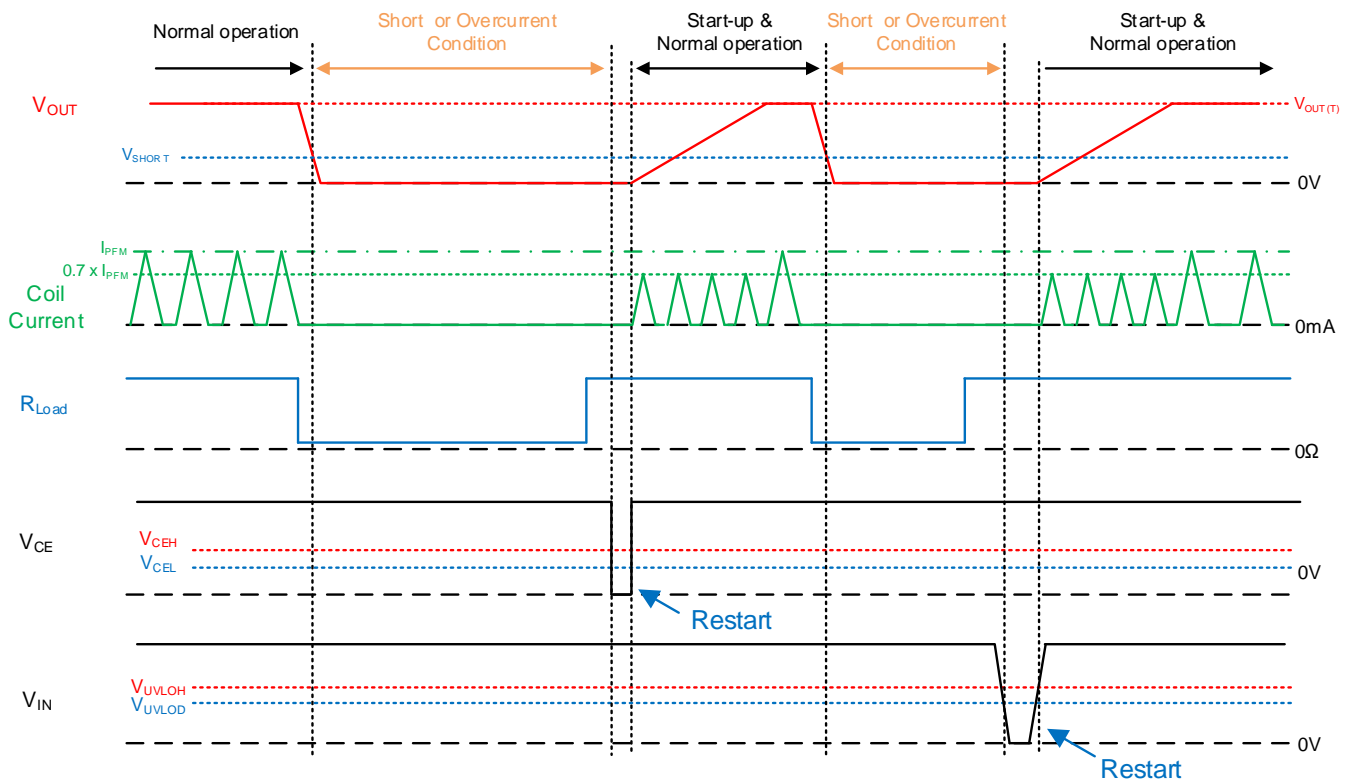
<Short protection function>

• Case (a) : $V_{OUT1} \geq 1.2V$

The short-circuit protection function monitors the V_{OUT} pin voltage, and if the V_{OUT} pin voltage drops below the Short Protection Threshold Voltage (V_{SHORT}) due to a short circuit or overcurrent, the short circuit protection function operates.

When the short-circuit protection function is activated, the Pch driver FET and Nch driver FET are held off. If the V_{OUT} pin voltage exceeds the Short Protection Threshold Voltage (V_{SHORT}) after the short-circuit protection function is activated, normal operation resumes.

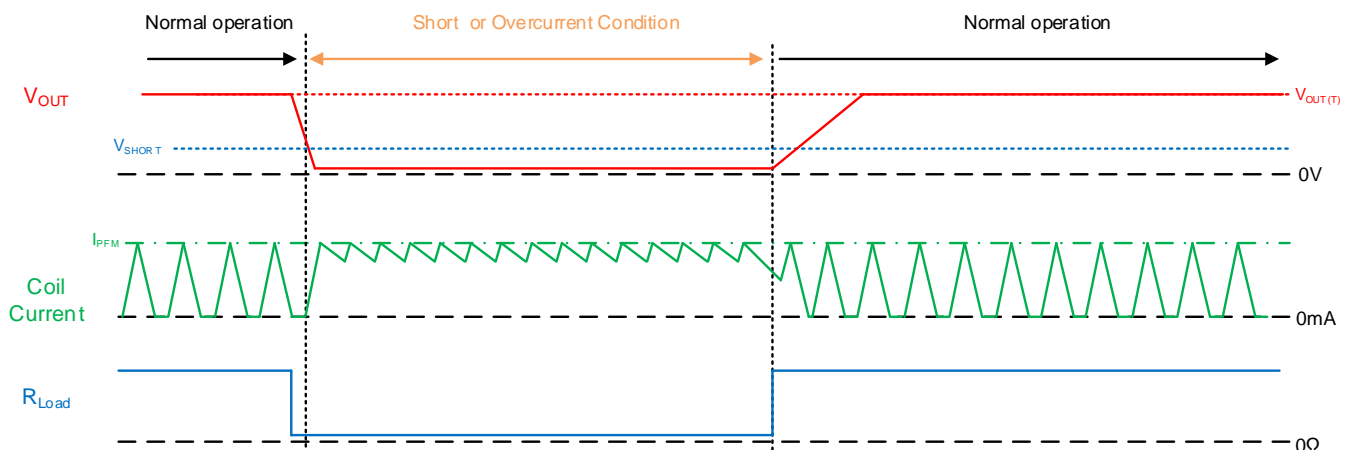
To cancel the short-circuit protection function, it is necessary to start the IC after putting the IC in the standby state with the CE function, or to raise the input voltage after setting the input voltage below the UVLO detection voltage (V_{UVLOD}).



• Case (b) : $V_{OUT1} < 1.2V$

The short-circuit protection function is not implemented in the part numbers where V_{OUT1} is less than 1.2V. If a short circuit or overcurrent occurs, the output voltage will drop and switching operation will continue.

When the short-circuit state or excessive output current is released, the output voltage rises quickly to the set output voltage.



OPERATIONAL EXPLANATION (Continued)

< CL Discharge function (D type)>

On the XC9276 series, a CL discharge function is available as an option.

CL discharge function turns on the Nch FET M1 between the VOUT pin and GND pin when the stand-by condition in order to discharge the output capacitance quickly and make the output voltage be lower.

This prevents malfunctioning of the application in the event that a charge remains on CL when the IC is stand-by state.

The discharge time is determined by CL and the CL discharge resistance RDCHG, including the Nch FET M1. the discharge time of the output voltage is calculated by means of the equation below.

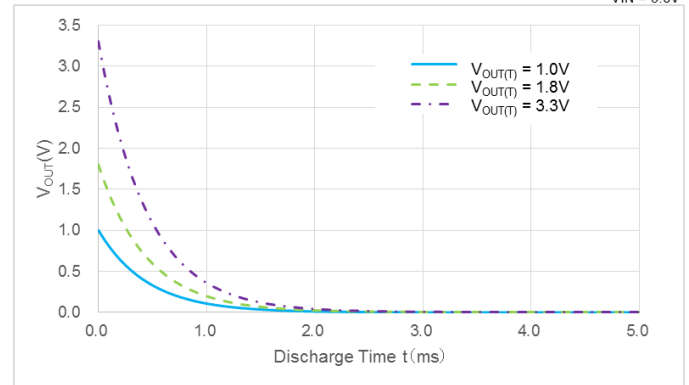
$$V = V_{OUT(T)} \times e^{-t/\tau}$$

$$t = \tau \ln(V_{OUT(T)} / V)$$

- V : Output voltage during discharge
- VOUT(T) : Output voltage
- t : Discharge time
- CL : Effective capacitance of Output capacitor
- RDCHG : CL auto-discharge resistance
- τ : $CL \times RDCHG$

Output Voltage Discharge characteristics

RDCHG = 45Ω (TYP) CL = 10μF
VIN = 5.0V



<Output Voltage selectable function>

When "H" voltage (VSETH) is fed to the VSET pin, the set output voltage operates as VOUT2, and when "L" voltage (VSETL) is fed, the set output voltage operates as VOUT1.

When the VSET pin voltage is switched during normal operation, the set output voltage is changed to the changed output voltage after a certain period.

| VSET SIGNAL | Output Voltage | Comment |
|-------------|----------------------------------|--|
| H | VOUT2 | - |
| L | VOUT1 | - |
| H → L | VOUT2 → VOUT1 (VOUT1 < VOUT2) | Output voltage starts to drop to VOUT1 30μs after "L" input. Falling speed depends on output current. |
| | VOUT2 → VOUT1 (VOUT1 > VOUT2) | Output voltage starts to rise to VOUT1 30μs after "L" input. Rise speed depends on IPFM. |
| L → H | VOUT1 → VOUT2 (VOUT1 < VOUT2) | Output voltage starts to rise to VOUT2 30μs after "H" input. Rise speed depends on IPFM. |
| | VOUT1 → VOUT2 (VOUT1 > VOUT2) | Output voltage starts to drop to VOUT2 30μs after "H" input. Falling speed depends on output current. |

■ NOTE ON USE

1. Be careful not to exceed the absolute maximum ratings for externally connected components and this IC.
2. The DC/DC converter characteristics greatly depend not only on the characteristics of this IC but also on those of externally connected components, so refer to EXTERNAL COMPONENTS SELECTION and the specifications of each component and be careful when selecting the components. Be especially careful of the characteristics of the capacitor used for the load capacity C_L and use a capacitor with B characteristics (JIS Standard) or an X7R/X5R (EIA Standard) ceramic capacitor.
3. The CE pin and VSET pin does not have an internal pull-up or pull-down, etc. Apply the prescribed voltage to the CE pin and VSET pin.
If an intermediate voltage is fed to the CE and VSET pins, a through current will flow through the input stage of the CE and VSET pins, increasing current consumption.
4. At light loads or when IC operation is stopped, leakage current from the Pch driver FET may cause the output voltage to rise.
5. Switching operation may be performed continuously due to internal delay or input offset of the PFM comparator circuit.
If the switching operation continues, the output ripple voltage increases and the output voltage rises as the ripple voltage increases.
6. When the input / output potential difference is small, the ripple voltage increases and the output voltage may increase.
7. Since the short-circuit protection function is not implemented in the part number where both of or either V_{OUT1} or V_{OUT2} is less than 1.2V, the coil current may be superposed under the condition of high input voltage and excessive output current.
8. During start-up mode, the peak current of the coil is set lower than in normal operation, so the output voltage may not rise under conditions where the output current is large during start-up.
9. To suppress current consumption, UVLO detection is performed only for a certain period after the Pch driver FET is turned on.
For this reason, the UVLO function may not operate if the VIN pin voltage instantaneously drops below the UVLO detection voltage (V_{UVLOD}).
10. Under the conditions of $V_{in} \leq 2.7V$, set output voltage $\leq 1.0V$ and $T_a \geq 65^\circ C$, the efficiency can drastically drop.
Normally after the Nch driver FET turns on, the coil current falls to 0mA, and then Nch driver FET turns off.
Under the above conditions, however, before the coil current falls to 0mA, Nch driver FET turns off and its loss increases, which leads to the drop of efficiency.
11. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
12. Torex places an importance on improving our products and their reliability. We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

NOTE ON USE (Continued)

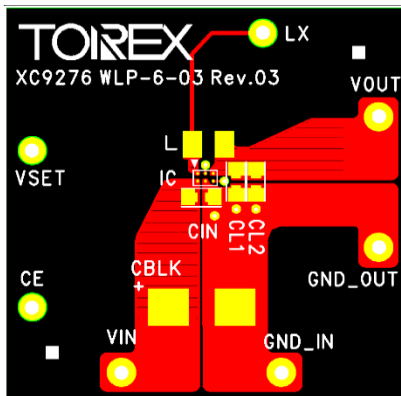
13. Instructions of pattern layouts

- (1) In order to stabilize V_{IN} voltage level, we recommend that a by-pass capacitor (C_{IN}) be connected as close as possible to the V_{IN} & GND pins.
- (2) Please mount each external component as close to the IC as possible.
- (3) Wire external components as close to the IC as possible and use thick, short connecting traces to reduce the circuit impedance.
- (4) Make sure that the PCB GND traces are as thick as possible, as variations in ground potential caused by high ground currents at the time of switching may result in instability of the IC.
- (5) This series' internal driver FET bring on heat because of the output current and ON resistance of Pch driver FET.

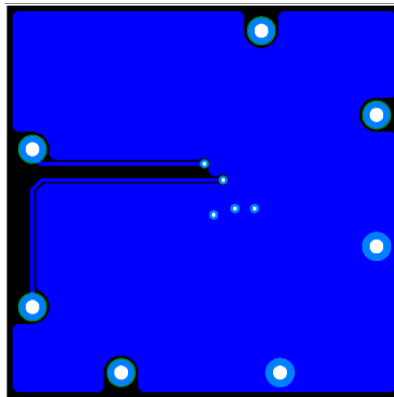
<Reference pattern layout >

WLP-6-03

Layer 1

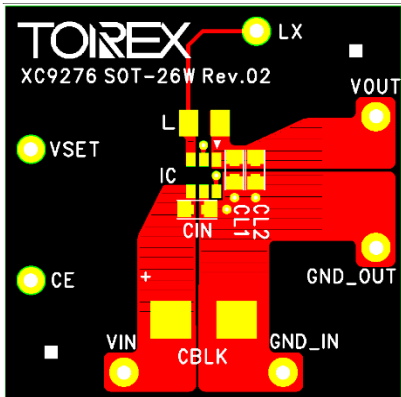


Layer 2

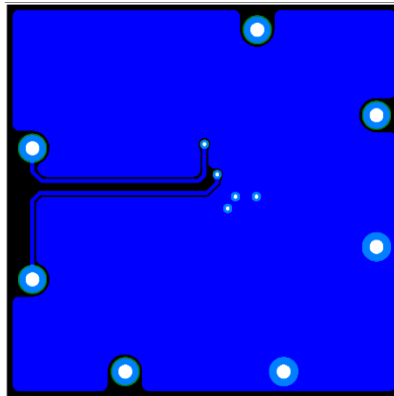


SOT-26W

Layer 1

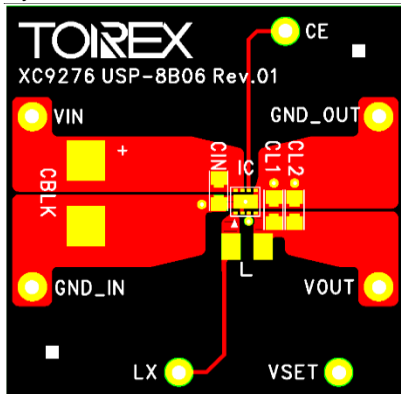


Layer 2

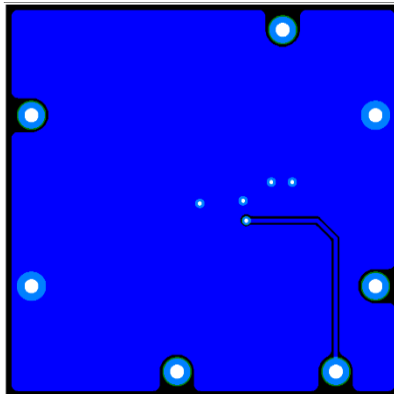


USP-8B06

Layer 1



Layer 2



■ NOTE ON USE (Continued)

14. Note on mounting (WLP)

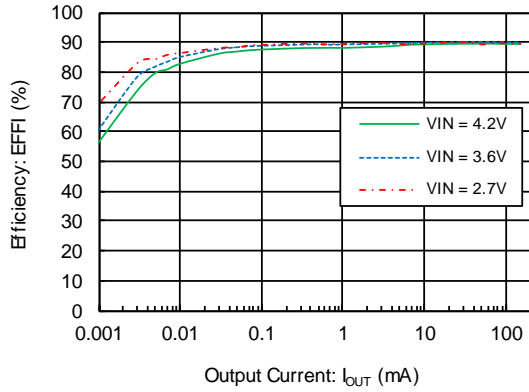
- (1) Mount pad design should be optimized for user's conditions.
- (2) Sn-AG-Cu is used for the package terminals. If eutectic solder is used, mounting reliability is decreased. Please do not use eutectic solder paste.
- (3). When underfill agent is used to increase interfacial bonding strength, please take enough evaluation for selection. Some underfill materials and applied conditions may decrease bonding reliability.
- (4) The IC has exposed surface of silicon material in the top marking face and sides so that it is weak against mechanical damages. Please take care of handling to avoid cracks and breaks.
- (5) The IC has exposed surface of silicon material in the top marking face and sides. Please use the IC with keeping the circuit open (avoiding short-circuit from the out).
- (6) Semi-transparent resin is coated on the circuit face of the package. Please be noted that the usage under strong lights may affects device performance.

TYPICAL PERFORMANCE CHARACTERISTICS

(1) Efficiency vs. Output Current

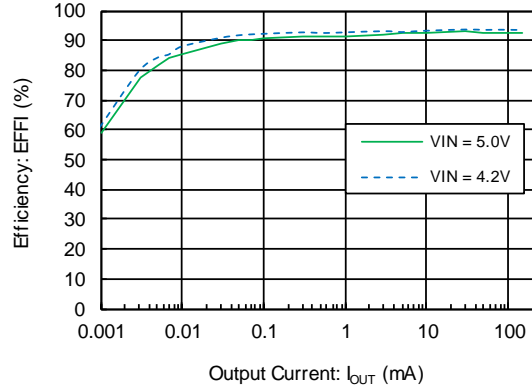
XC9276($V_{OUT}=1.8V$)

$L = \text{GLUHK2R201A}(2.2\mu\text{H})$
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$



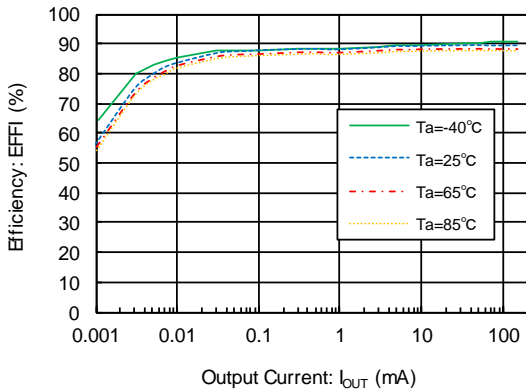
XC9276($V_{OUT}=3.0V$)

$L = \text{GLUHK2R201A}(2.2\mu\text{H})$
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$



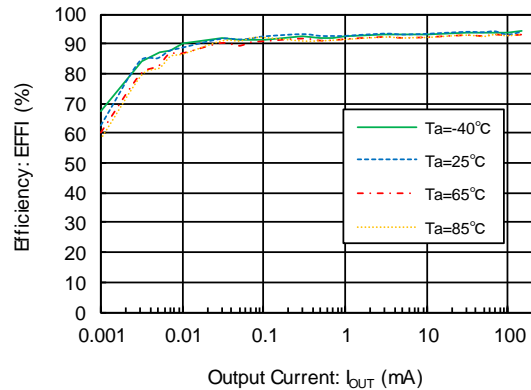
XC9276($V_{OUT}=1.8V$)

$V_{IN} = 3.6V$
 $L = \text{GLUHK2R201A}(2.2\mu\text{H})$
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$



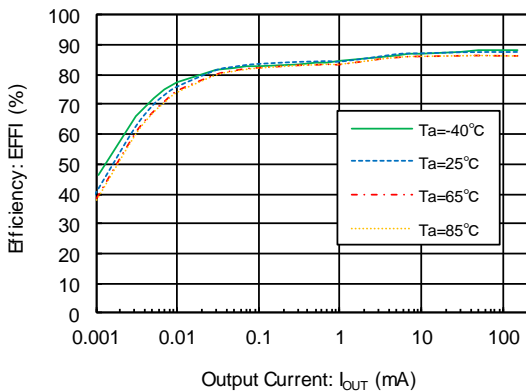
XC9276($V_{OUT}=3.0V$)

$V_{IN} = 3.6V$
 $L = \text{GLUHK2R201A}(2.2\mu\text{H})$
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$



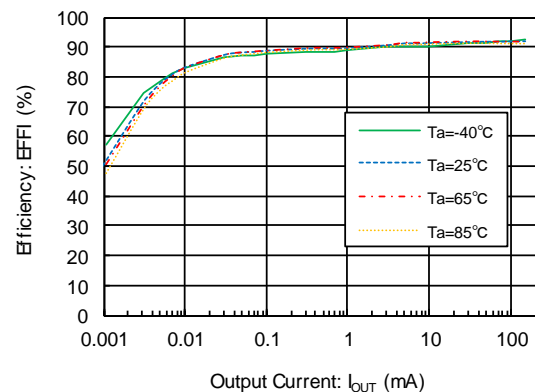
XC9276($V_{OUT}=1.8V$)

$V_{IN} = 5.0V$
 $L = \text{GLUHK2R201A}(2.2\mu\text{H})$
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$



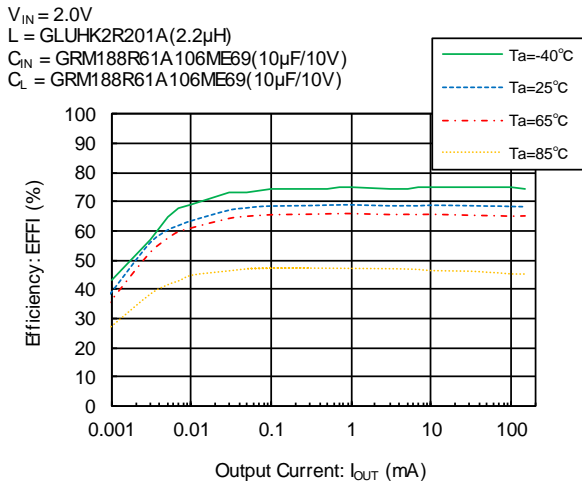
XC9276($V_{OUT}=3.0V$)

$V_{IN} = 5.0V$
 $L = \text{GLUHK2R201A}(2.2\mu\text{H})$
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$

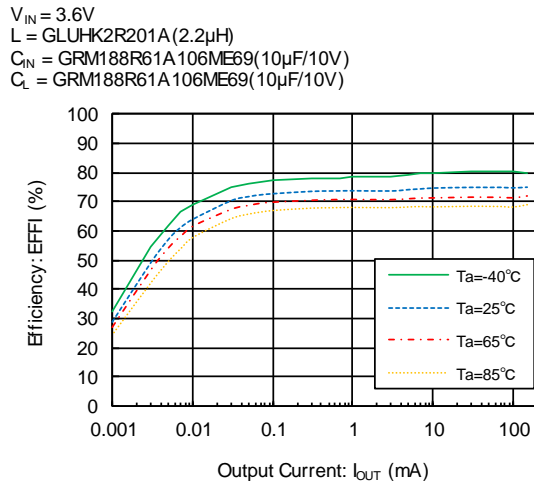


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

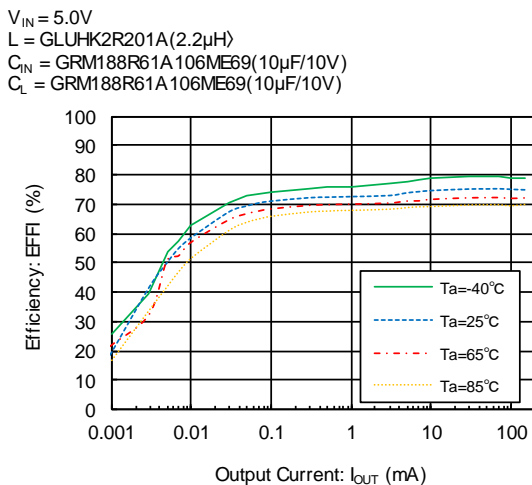
XC9276($V_{OUT}=0.5V$)



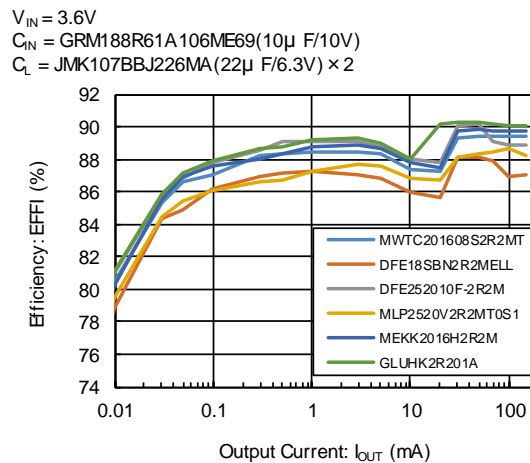
XC9276($V_{OUT}=0.5V$)



XC9276($V_{OUT}=0.5V$)

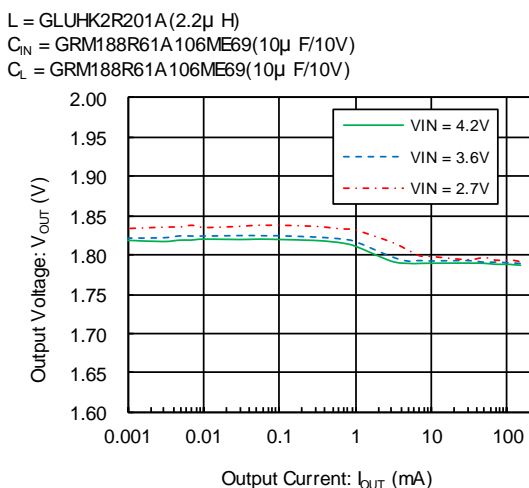


XC9276($V_{OUT}=1.8V$)

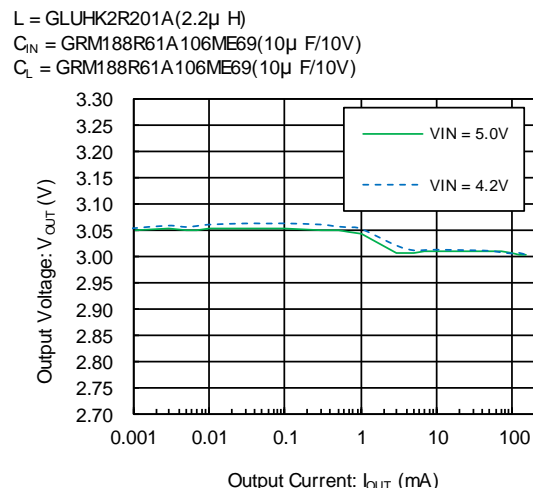


(2) Output Voltage vs. Output Current

XC9276($V_{OUT}=1.8V$)



XC9276($V_{OUT}=3.0V$)

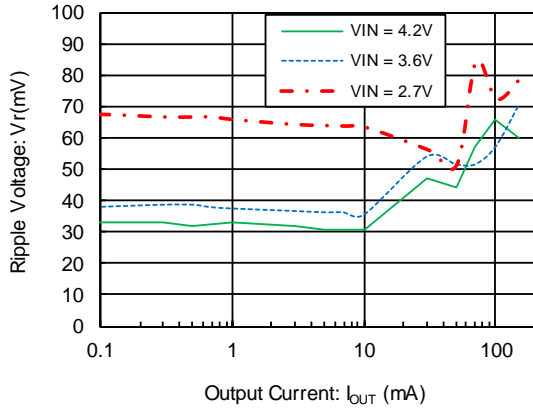


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Ripple Voltage vs. Output Current

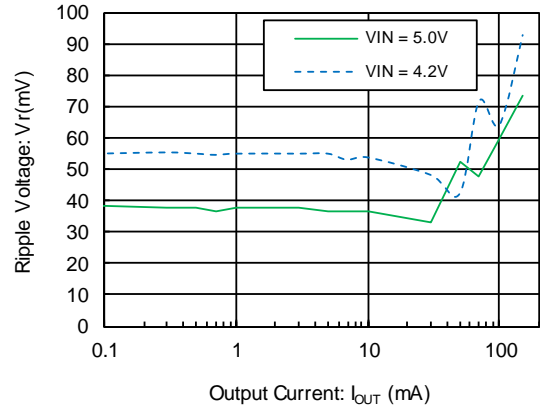
XC9276($V_{OUT}=1.8V$)

L = GLUHK2R201A(2.2 μ H)
 C_{IN} = GRM188R61A106ME69(10 μ F/10V)
 C_L = GRM188R61A106ME69(10 μ F/10V)



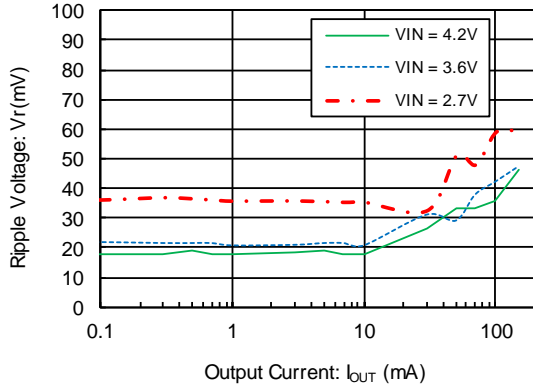
XC9276($V_{OUT}=3.0V$)

L = GLUHK2R201A(2.2 μ H)
 C_{IN} = GRM188R61A106ME69(10 μ F/10V)
 C_L = GRM188R61A106ME69(10 μ F/10V)



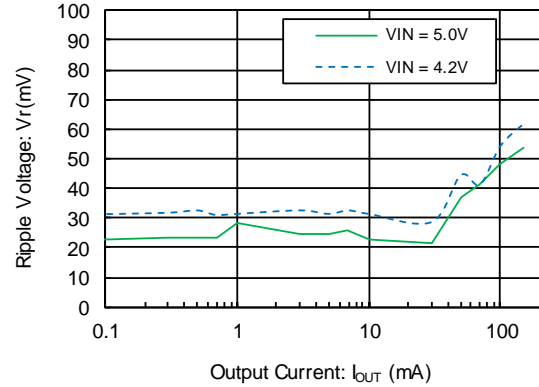
XC9276($V_{OUT}=1.8V$)

L = GLUHK2R201A(2.2 μ H)
 C_{IN} = GRM188R61A106ME69(10 μ F/10V)
 C_L = JMK107BBJ226MA(22 μ F/6.3V)



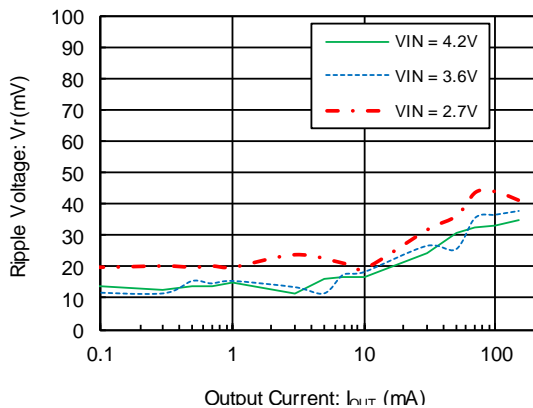
XC9276($V_{OUT}=3.0V$)

L = GLUHK2R201A(2.2 μ H)
 C_{IN} = GRM188R61A106ME69(10 μ F/10V)
 C_L = JMK107BBJ226MA(22 μ F/6.3V)



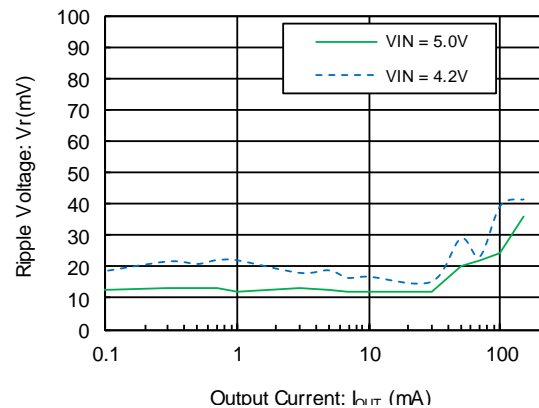
XC9276($V_{OUT}=1.8V$)

L = GLUHK2R201A(2.2 μ H)
 C_{IN} = GRM188R61A106ME69(10 μ F/10V)
 C_L = JMK107BBJ226MA(22 μ F/6.3V) $\times 2$



XC9276($V_{OUT}=3.0V$)

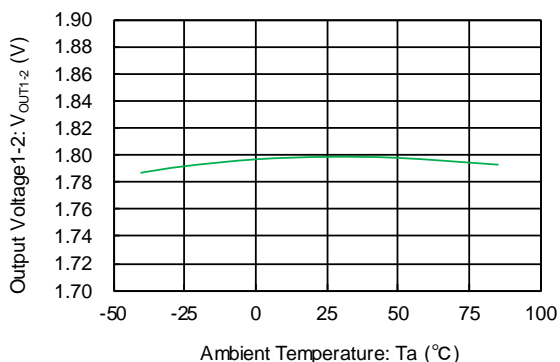
L = GLUHK2R201A(2.2 μ H)
 C_{IN} = GRM188R61A106ME69(10 μ F/10V)
 C_L = JMK107BBJ226MA(22 μ F/6.3V) $\times 2$



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

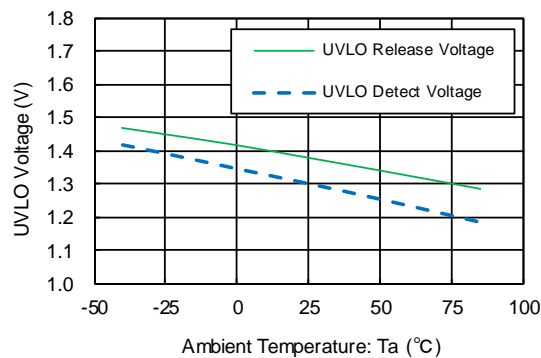
(4) Output Voltage vs. Ambient Temperature

XC9276($V_{OUT1}=1.8V$)



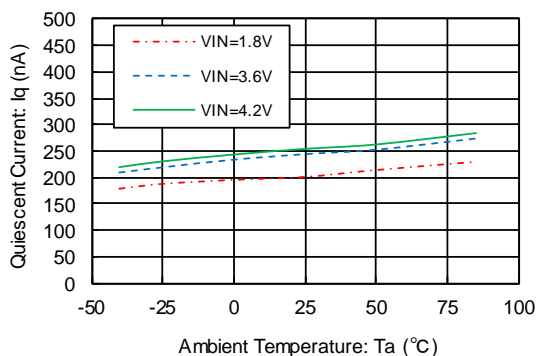
(5) UVLO Voltage vs. Ambient Temperature

XC9276



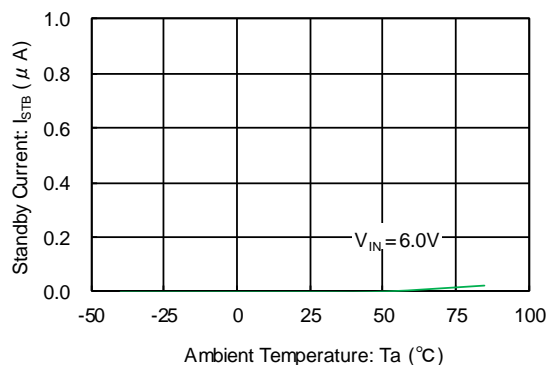
(6) Quiescent Current vs. Ambient Temperature

XC9276($V_{OUT}=0.6V$)



(7) Stand-by Current vs. Ambient Temperature

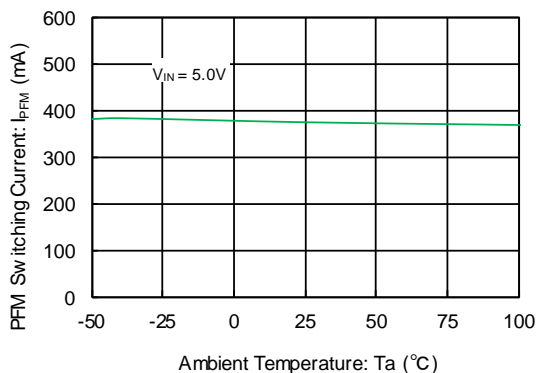
XC9276



(8) PFM Switching Current vs. Ambient Temperature

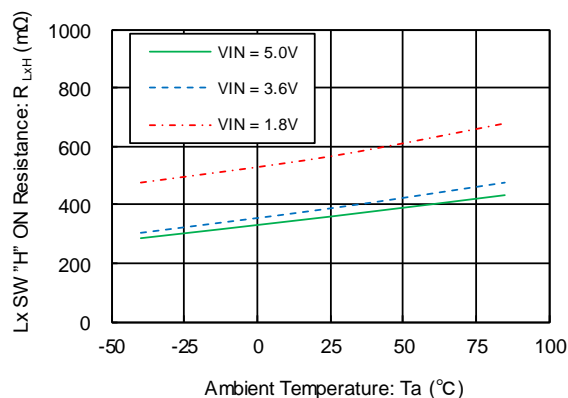
XC9276($V_{OUT}=0.6V$)

$L = \text{GLUHK2R201A}(2.2\mu\text{H})$,
 $C_{IN} = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$
 $C_L = \text{GRM188R61A106ME69}(10\mu\text{F}/10V)$



(9) Lx SW "H" ON Resistance vs. Ambient Temperature

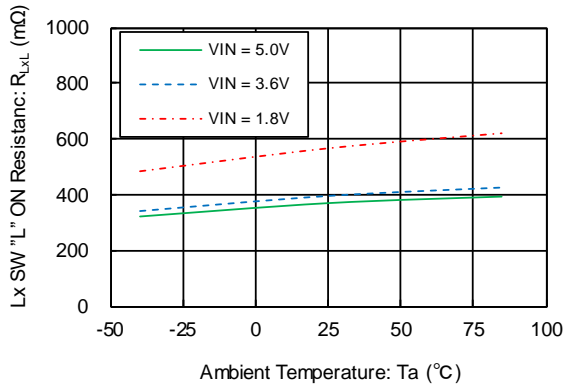
XC9276



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

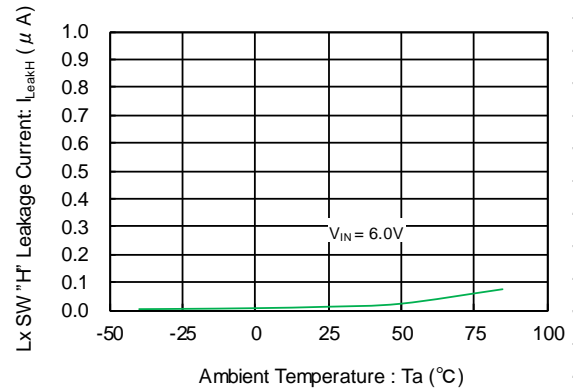
(10) Lx SW "L" ON Resistance vs. Ambient Temperature

XC9276



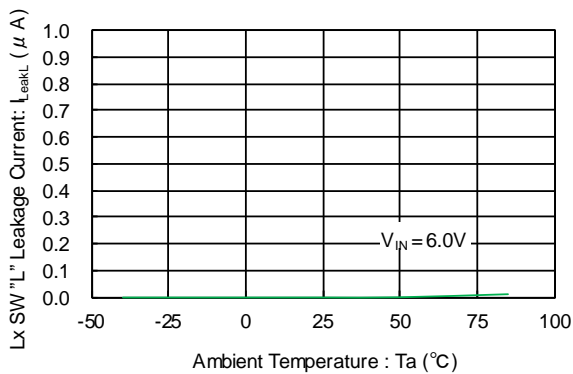
(11) Lx SW "H" Leakage Current vs. Ambient Temperature

XC9276



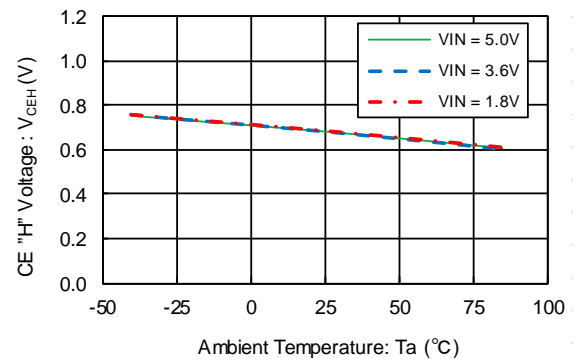
(12) Lx SW "L" Leakage Current vs. Ambient Temperature

XC9276



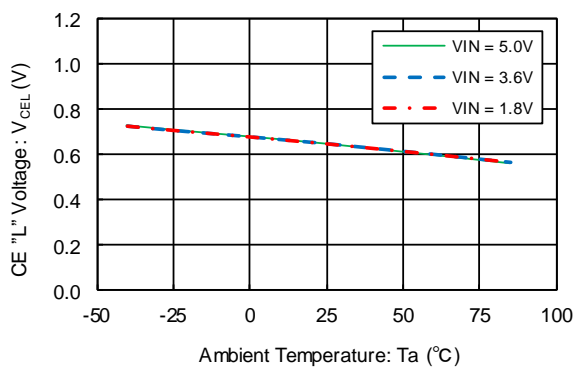
(13) CE "H" Voltage vs. Ambient Temperature

XC9276



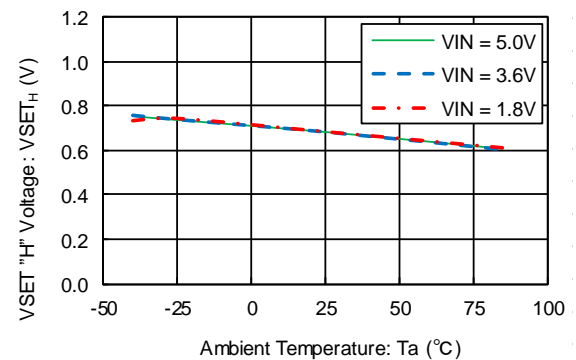
(14) CE "L" Voltage vs. Ambient Temperature

XC9276



(15) VSET "H" Voltage vs. Ambient Temperature

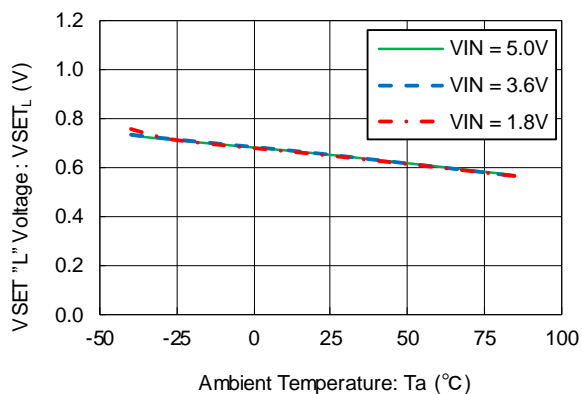
XC9276



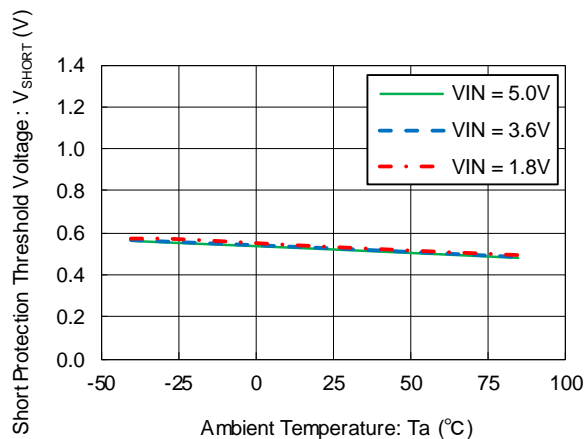
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(16) VSET "L" Voltage vs. Ambient Temperature

XC9276

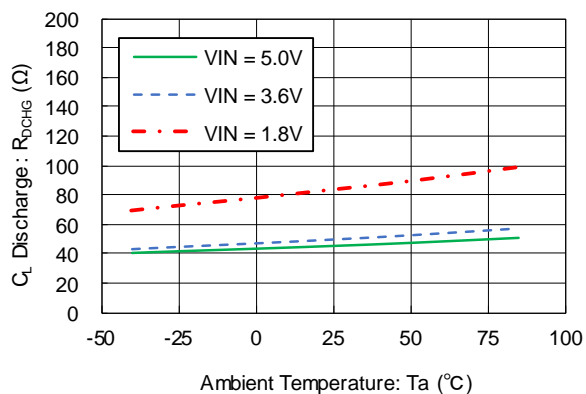


(17) Short Protection Threshold vs. Ambient Temperature



(18) C_L Discharge Resistance vs. Ambient Temperature

XC9276

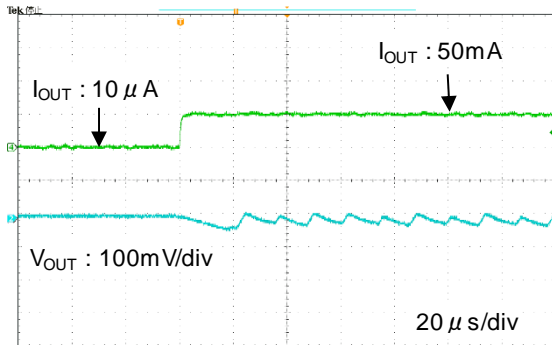


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(19) Load Transient Responses

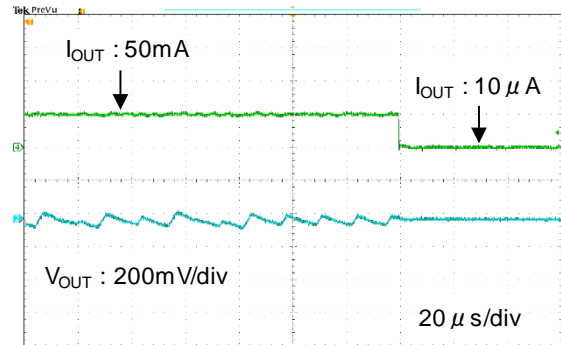
XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT} = 1.8V$, $V_{SET} = 0.0V$, $I_{OUT} = 10\mu A \Rightarrow 50mA$
 $tr = 5\mu s$
 $L = GLUHK2R201A(2.2\mu H)$
 $C_{IN} = GRM188R61A106ME69(10\mu F/10V)$
 $C_L = JMK107BBJ226MA(22\mu F/6.3V) \times 2$



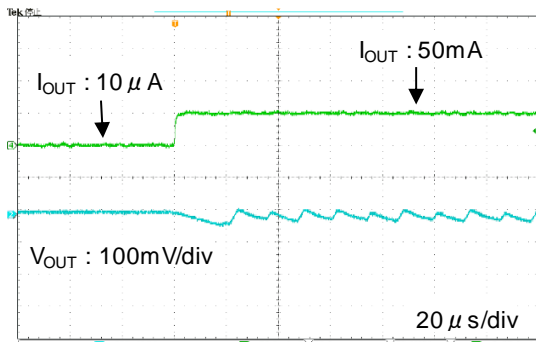
XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT} = 1.8V$, $V_{SET} = 0V$, $I_{OUT} = 50mA \Rightarrow 10\mu A$
 $tf = 5\mu s$
 $L = GLUHK2R201A(2.2\mu H)$
 $C_{IN} = GRM188R61A106ME69(10\mu F/10V)$
 $C_L = JMK107BBJ226MA(22\mu F/6.3V) \times 2$



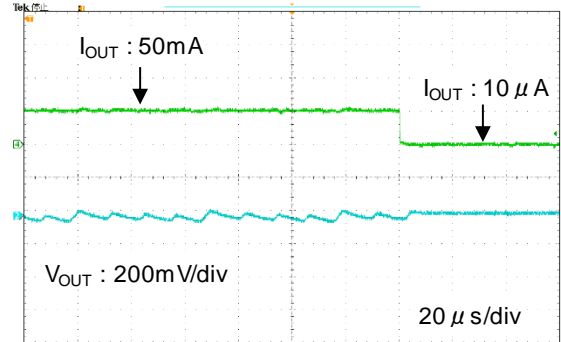
XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT} = 3.0V$, $V_{SET} = 3.6V$, $I_{OUT} = 10\mu A \Rightarrow 50mA$
 $tr = 5\mu s$
 $L = GLUHK2R201A(2.2\mu H)$
 $C_{IN} = GRM188R61A106ME69(10\mu F/10V)$
 $C_L = JMK107BBJ226MA(22\mu F/6.3V) \times 2$



XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT} = 3.0V$, $V_{SET} = 3.6V$, $I_{OUT} = 50mA \Rightarrow 10\mu A$
 $tf = 5\mu s$
 $L = GLUHK2R201A(2.2\mu H)$
 $C_{IN} = GRM188R61A106ME69(10\mu F/10V)$
 $C_L = JMK107BBJ226MA(22\mu F/6.3V) \times 2$

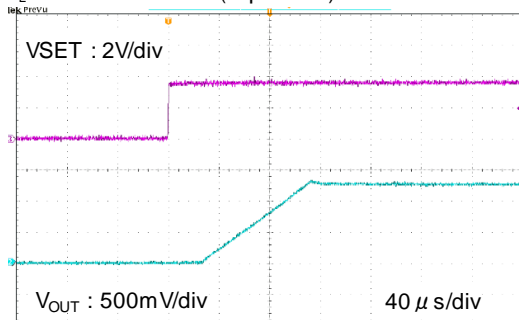


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(20) Output voltage selectable function

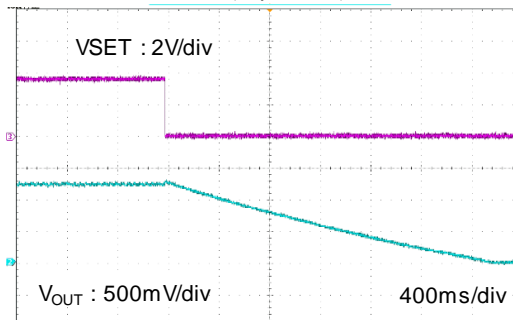
XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT(T)} = 1.8V \Rightarrow 3.0V$, $I_{OUT} = 10 \mu A$
 $V_{SET} = 0.0V \Rightarrow 3.6V$, $t_r = 5 \mu s$
 $L = \text{GLUHK2R201A}(2.2 \mu H)$
 $C_{IN} = \text{GRM188R61A106ME69}(10 \mu F/10V)$
 $C_L = \text{JMK107BBJ226MA}(22 \mu F/6.3V) \times 2$



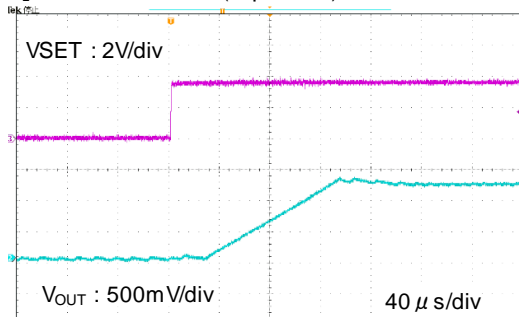
XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT(T)} = 3.0V \Rightarrow 1.8V$, $I_{OUT} = 10 \mu A$
 $V_{SET} = 3.6V \Rightarrow 0.0V$, $t_f = 5 \mu s$
 $L = \text{GLUHK2R201A}(2.2 \mu H)$
 $C_{IN} = \text{GRM188R61A106ME69}(10 \mu F/10V)$
 $C_L = \text{JMK107BBJ226MA}(22 \mu F/6.3V) \times 2$



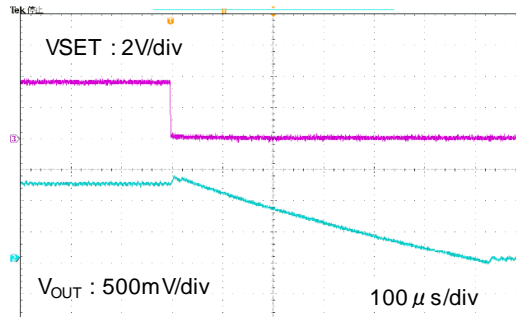
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$V_{IN} = 3.6V$, $V_{OUT(T)} = 1.8V \Rightarrow 3.0V$, $I_{OUT} = 50mA$
 $V_{SET} = 0.0V \Rightarrow 3.6V$, $t_r = 5 \mu s$
 $L = \text{GLUHK2R201A}(2.2 \mu H)$
 $C_{IN} = \text{GRM188R61A106ME69}(10 \mu F/10V)$
 $C_L = \text{JMK107BBJ226MA}(22 \mu F/6.3V) \times 2$



XC9276DB90

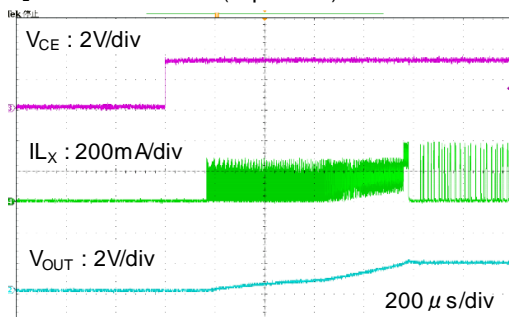
$V_{IN} = 3.6V$, $V_{OUT(T)} = 3.0V \Rightarrow 1.8V$, $I_{OUT} = 50mA$
 $V_{SET} = 3.6V \Rightarrow 0.0V$, $t_f = 5 \mu s$
 $L = \text{GLUHK2R201A}(2.2 \mu H)$
 $C_{IN} = \text{GRM188R61A106ME69}(10 \mu F/10V)$
 $C_L = \text{JMK107BBJ226MA}(22 \mu F/6.3V) \times 2$



(21) Startup Mode

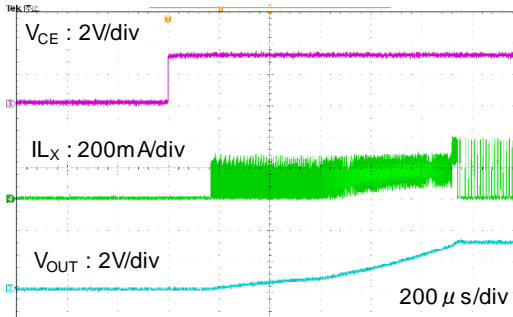
XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT} = 1.8V$, $V_{CE} = 0.0V \Rightarrow 3.6V$, $I_{OUT} = 50mA$
 $t_r = 5 \mu s$
 $L = \text{GLUHK2R201A}(2.2 \mu H)$
 $C_{IN} = \text{GRM188R61A106ME69}(10 \mu F/10V)$
 $C_L = \text{JMK107BBJ226MA}(22 \mu F/6.3V) \times 2$



XC9276DB90

$V_{IN} = 3.6V$, $V_{OUT} = 3.0V$, $V_{CE} = 0.0V \Rightarrow 3.6V$, $I_{OUT} = 50mA$
 $t_r = 5 \mu s$
 $L = \text{GLUHK2R201A}(2.2 \mu H)$
 $C_{IN} = \text{GRM188R61A106ME69}(10 \mu F/10V)$
 $C_L = \text{JMK107BBJ226MA}(22 \mu F/6.3V) \times 2$



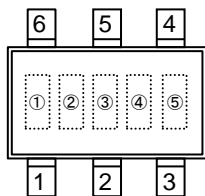
■ PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

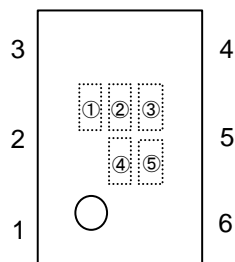
| PACKAGE | OUTLINE / LAND PATTERN | THERMAL CHARACTERISTICS |
|----------|------------------------------|--|
| WLP-6-03 | WLP-6-03 PKG | WLP-6-03 Power Dissipation |
| SOT-26W | SOT-26W PKG | SOT-26W Power Dissipation |
| USP-8B06 | USP-8B06 PKG | USP-8B06 Power Dissipation |

MARKING RULE

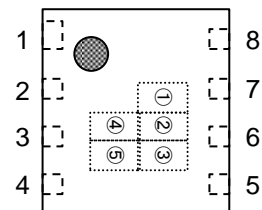
SOT-26W



WLP-6-03



USP-8B06



① represents product series

| MARK | PRODUCT SERIES |
|------|----------------|
| A | XC9276*****R-G |

②,③ represents internal sequential number

01~09, 10~99, A0~A9, B0~B9...Z0~Z9, AA~AZ, BA~BZ...ZA~ZZ repeated.

(G, I, J, O, Q, W excluded)

④,⑤ represents production lot number

01~09, 0A~0Z, 11...9Z, A1~A9, AA...Z9, ZA~ZZ in order.

(G, I, J, O, Q, W excluded)

* No character inversion used.

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